SONY

Diagonal 8.35 mm (Type 1/2) CMOS Solid-state Image Sensor with Square Pixel for Color Cameras

IMX385LQR-C

Description

The IMX385LQR-C is a diagonal 8.35 mm (Type 1/2) CMOS active pixel type solid-state image sensor with a square pixel array and 2.13 M effective pixels. This chip operates with analog 3.3 V, digital 1.2 V, and interface 1.8 V triple power supply, and has low power consumption. High sensitivity, low dark current and no smear are achieved through the adoption of R, G and B primary color mosaic filters. This chip features an electronic shutter with variable charge-integration time.

(Applications: Surveillance cameras)

Features

- ◆ CMOS active pixel type dots
- Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆ Input frequency: 74.25 MHz / 37.125 MHz
- ◆ Number of recommended recording pixels: 1920 (H) × 1080 (V) approx. 2.07 M pixels
- ◆ Readout mode

All-pixel scan mode / Window cropping mode

Vertical / Horizontal direction: normal / inverted readout mode

Readout rate

Maximum frame rate in All-pixel scan mode: 120 frame / s

- ♦ Wide dynamic range (WDR) function Multiple exposure WDR Digital overlap WDR
- ◆ Variable-speed shutter function (resolution 1H units)
- ◆ 10-bit / 12-bit A/D converter
- ◆ Conversion gain switching (HCG Mode / LCG Mode)
- ◆ CDS / PGA function

0 dB to 30 dB: Analog Gain 30 dB (step pitch 0.1 dB)

30.1 dB to 72 dB: Analog Gain 30 dB + Digital Gain 0.1 to 42 dB (step pitch 0.1 dB)

- ◆ Supports I/O switching
 - Low voltage LVDS (150 mVp-p) serial (2 ch / 4 ch / 8 ch switching) DDR output CSI-2 serial data output (2 Lane / 4 Lane, RAW10 / RAW12 output)
- ◆ Recommended lens F number: 2.8 or more (Close side)
- ◆ Recommended exit pupil distance: -30 mm to -∞

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Device Structure

- ◆ CMOS image sensor
- ◆ Image size Type 1/2
- ◆ Total number of pixels 1952 (H) x 1113 (V) approx. 2.17 M pixels
- ◆ Number of effective pixels 1945 (H) x 1097 (V) approx. 2.13 M pixels
- ◆ Number of active pixels 1937 (H) x 1097 (V) approx. 2.12 M pixels
- ◆ Number of recommended recording pixels 1920 (H) x 1080 (V) approx. 2.07 M pixels
- ◆ Unit cell size $3.75 \mu m (H) \times 3.75 \mu m (V)$
- ◆ Optical black Horizontal (H) direction: Front 4 pixels, rear 0 pixels Vertical (V) direction: Front 16 pixels, rear 0 pixels
- Pomertek Chonb Co. Itd. **♦** Dummy Horizontal (H) direction: Front 0 pixels, rear 3 pixels Vertical (V) direction: Front 0 pixels, rear 0 pixels
- ◆ Substrate material Silicon

Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remarks
Supply voltage (analog 3.3 V)	AV_{DD}	-0.3	4.0	V	_
Supply voltage (interface 1.8 V)	OV_{DD}	-0.3	3.3	V	_
Supply voltage (digital 1.2 V)	DV_DD	-0.3	2.0	V	_
Input voltage	VI	-0.3	OV _{DD} + 0.3	V	Not exceed 3.3 V
Output voltage	VO	-0.3	OV _{DD} + 0.3	V	Not exceed 3.3 V
Operating temperature	Topr	-30	85	°C	_
Storage temperature	Tstg	-40	85	°C	_

Recommended Operating Conditions

Item	Symbol	Min.	Тур.	Max.	Unit
Supply voltage (analog 3.3 V)	AV _{DD}	3.15	3.30	3.45	V
Supply voltage (Interface 1.8 V)	OV_{DD}	1.70	1.80	1.90	V
Supply voltage (digital 1.2 V)	DV _{DD}	1.10	1.20	1.30	V
Rome	ite to	JIIR Co			

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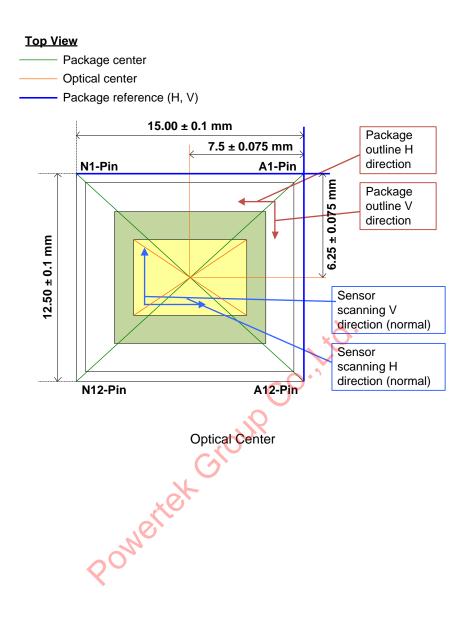
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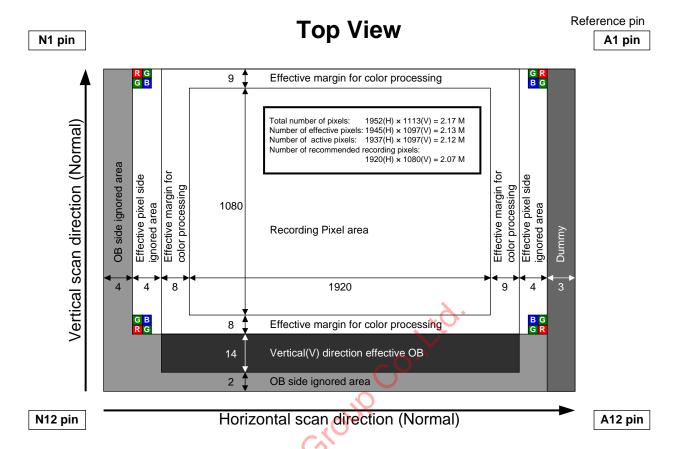
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Optical Center



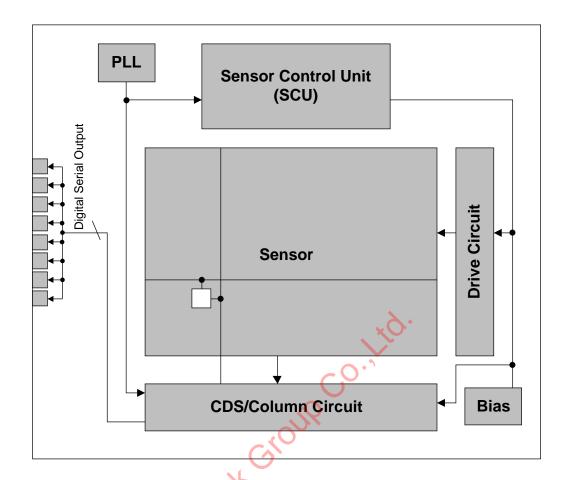
Pixel Arrangement



^{*} Reference pin number is consecutive numbering of package pin array. See the Pin Configuration for the number of each pin.

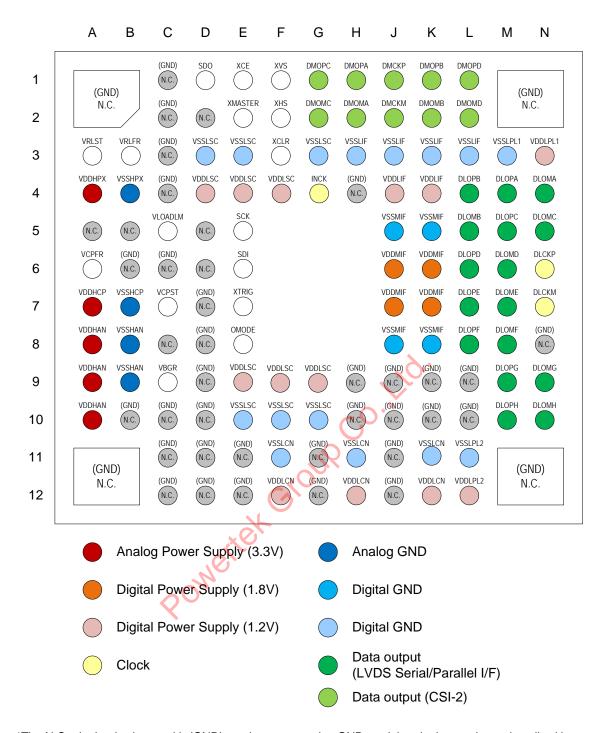
Pixel Arrangement (Top View)

Block Diagram and Pin Configuration



Block Diagram

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*The N.C. pin that is shown with (GND) can be connected to GND, and the pin that not been described have to open.

Pin Configuration (Bottom View)

Pin Description

No.	Pin No.	I/O	Analog /Digital	Symbol	Description	Remarks
1	A1	_	_	N.C.	_	GND connectable
2	А3	I	Α	VRLST	Connected to VCPST pin	_
3	A4	Power	Α	VDDHPX	3.3 V power supply	_
4	A5		_	N.C.	_	_
5	A6	0	Α	VCPFR	Connected to VRLFR pin.	_
6	A7	Power	Α	VDDHCP	3.3 V power supply	_
7	A8	Power	Α	VDDHAN	3.3 V power supply	_
8	A9	Power	Α	VDDHAN	3.3 V power supply	_
9	A10	Power	Α	VDDHAN	3.3 V power supply	_
10	A12	_	_	N.C.	_	GND connectable
11	В3	I	Α	VRLFR	Connected to VCPFR pin.	_
12	B4	_	Α	VSSHPX	3.3 V GND	_
13	B5	_	_	N.C.	_	_
14	B6	_	_	N.C.	_	GND connectable
15	B7	GND	Α	VSSHCP	3.3 V GND	_
16	B8	GND	Α	VSSHAN	3.3 V GND	_
17	B9	GND	Α	VSSHAN	3.3 V GND	_
18	B10	_	_	N.C.	× ()	GND connectable
19	C1	_	_	N.C.		GND connectable
20	C2	_	_	N.C.		GND connectable
21	C3	_	_	N.C.	<u> </u>	GND connectable
22	C4	_	_	N.C.	<u> </u>	GND connectable
23	C5	0	Α	VLOADLM	Reference pin	_
24	C6	_	_	N.C.	_	GND connectable
25	C7	0	_	VCPST	Connected to VRLST pin.	_
26	C8	_	_	N.C.	-	_
27	C9	0	Α	VBGR	Reference pin	_
28	C10	_	_	N.C.	-	GND connectable
29	C11		_	N.C.	_	GND connectable
30	C12		_	N.C.	_	GND connectable
31	D1	0	DO	SDO	Communication output 4-wire: SDO pin / I ² C: Open	_
32	D2	I	X	N.C.	-	_
33	D3	GND	D	VSSLSC	1.2 V GND	_
34	D4	Power	D	VDDLSC	1.2 V power supply	_
35	D5	_	_	N.C.	_	_
36	D6	_	_	N.C.	_	_
37	D7	_	_	N.C.	_	GND connectable
38	D8	_	_	N.C.	_	GND connectable
39	D9	_		N.C.	_	GND connectable
40	D10	_		N.C.	_	GND connectable
41	D11	_	_	N.C.	_	GND connectable
42	D12	_		N.C.	_	GND connectable

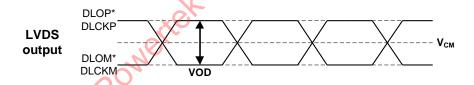
No.	Pin No.	I/O	Analog /Digital	Symbol	Description	Remarks
43	E1	I	D	XCE	Communication enable 4-wire: XCE pin. / I ² C: Fixed to High	_
44	E2	I	D	XMASTER	Master / Slave selection High: Slave mode / Low: Master mode	_
45	E3	GND	D	VSSLSC	1.2 V GND	_
46	E4	Power	D	VDDLSC	1.2 V power supply	_
			_		Communication clock	
47	E5	I	D	SCK	4-wire: SCK pin. / I ² C: SCL pin.	_
48	E6	I/O	D	SDI	Communication input 4-wire: SDI pin / I ² C: SDA pin	_
49	E7	I	D	XTRIG	TEST input pin.	_
50	E8	OMODE	D	OMODE	Serial output interface selection High: LVDS / Low: CSI-2	_
51	E9	Power	D	VDDLSC	1.2 V power supply	_
52	E10	GND	D	VSSLSC	1.2 V GND	
	E11	GND	D	N.C.	1.2 V GND	CND samestable
53		_	_		-	GND connectable
54	E12		_	N.C.	<u> </u>	GND connectable
55	F1	I/O	D	XVS	Vertical sync signal	_
56	F2	I/O	D	XHS	Horizontal sync signal	_
57	F3	ļ	D	XCLR	System clear (Normal; High / Clear: Low)	_
58	F4	Power	D	VDDLSC	1.2 V power supply	_
59	F9	Power	D	VDDLSC	1.2 V power supply	_
60	F10	GND	D	VSSLSC	1.2 V GND	_
61	F11	GND	D	VSSLCN	1.2 V GND	_
62	F12	Power	D	VDDLCN	1.2 V power supply	_
63	G1	0	D	DMOPC	CSI-2 output	_
64	G2	0	D	DMOMC	CSI-2 output	_
65	G3	GND	D	VSSLSC	1.2 V GND	_
66	G4	I	D	INCK	Master clock input	_
67	G9	Power	D	VDDLSC	1.2 V power supply	_
68	G10	GND	D	VSSLSC	1.2 V GND	
69	G11	OND		N.C.	1.2 V GIVD	GND connectable
70	G12		_	N.C.	_	GND connectable
71	H1	0		DMOPA	CSI-2 output	GND connectable
72		0	D			_
	H2			DMOMA	CSI-2 output	_
73	H3	GND	D		1.2 V GND	
74	H4	_	_	N.C.	-	GND connectable
75	H9	_	_	N.C.	<u> </u>	GND connectable
76	H10			N.C.	_	GND connectable
77	H11	GND	D	VSSLCN	1.2 V GND	_
78	H12	Power	D	VDDLCN	1.2 V power supply	_
79	J1	0	D	DMCKP	CSI-2 output clock	_
80	J2	0	D	DMCKM	CSI-2 output clock	_
81	J3	GND	D	VSSLIF	1.2 V GND	_
82	J4	Power	D	VDDLIF	1.2 V power supply	
83	J5	GND	D	VSSMIF	1.8 V GND	_
84	J6	Power	D	VDDMIF	1.8 V power supply	
85	J7	Power	D	VDDMIF	1.8 V power supply	_
86	J8	GND	D	VSSMIF	1.8 V GND	_
87	J9	_	_	N.C.	_	GND connectable
88	J10	_	_	N.C.	_	GND connectable
89	J11	_		N.C.	_	GND connectable
90	J12			N.C.	_	GND connectable
- 00	J 12		i	14.0.	<u>l</u>	C. 12 COMMODICADIO

NI-	Pin	1/0	Analog	Or see bod	December 1 and	Demode
No.	No.	I/O	/Digital	Symbol	Description	Remarks
91	K1	0	D	DMOPB	CSI-2 output	_
92	K2	0	D	DMOMB	CSI-2 output	_
93	K3	GND	D	VSSLIF	1.2 V GND	_
94	K4	Power	D	VDDLIF	1.2 V power supply	_
95	K5	GND	D	VSSMIF	1.8 V GND	_
96	K6	Power	D	VDDMIF	1.8 V power supply	_
97	K7	Power	D	VDDMIF	1.8 V power supply	_
98	K8	GND	D	VSSMIF	1.8 V GND	_
99	K9	_	_	N.C.	_	GND connectable
100	K10	_	_	N.C.	_	GND connectable
101	K11	GND	D	VSSLCN	1.2 V GND	_
102	K12	Power	D	VDDLCN	1.2 V power supply	_
103	L1	0	D	DMOPD	CSI-2 output	_
104	L2	0	D	DMOMD	CSI-2 output	_
105	L3	GND	D	VSSLIF	1.2 V GND	_
106	L4	0	D	DLOPB	LVDS output	_
107	L5	0	D	DLOMB	LVDS output	_
108	L6	0	D	DLOPD	LVDS output	_
109	L7	0	D	DLOPE	LVDS output	_
110	L8	0	D	DLOPF	LVDS output	_
111	L9	_	_	N.C.	<u> </u>	GND connectable
112	L10	_	_	N.C.	_	GND connectable
113	L11	GND	D	VSSLPL2	1.2 V GND	_
114	L12	Power	D	VDDLPL2	1.2 V power supply	_
115	М3	GND	D	VSSLPL1	1.2 V GND	_
116	M4	0	D	DLOPA	LVDS output	_
117	M5	0	D	DLOPC	LVDS output	_
118	M6	0	D	DLOMD	LVDS output	_
119	M7	0	D	DLOME	LVDS output	_
120	M8	0	D	DLOMF	LVDS output	_
121	M9	0	D	DLOPG	LVDS output	_
122	M10	0	D	DLOPH	LVDS output	_
123	N1	_		N.C.	_	GND connectable
124	N3	Power	D	VDDLPL1	1.2 V power supply	_
125	N4	0	D	DLOMA	LVDS output	_
126	N5	0	Ď	DLOMC	LVDS output	_
127	N6	0	D	DLCKP	LVDS data clock	_
128	N7	0	D	DLCKM	LVDS data clock	_
129	N8	_	_	N.C.	_	GND connectable
130	N9	0	D	DLOMG	LVDS output	_
131	N10	0	D	DLOMH	LVDS output	_
132	N12	_		N.C.	_	GND connectable

Electrical Characteristics

DC Characteristics

Ite	Item		Symbol	Condition	Min.	Тур.	Max.	Unit
analog VDDHx AV _L		AV _{DD}	_	3.15	3.30	3.45	V	
Supply voltage	Interface	VDDMx	OV _{DD} —		1.70	1.80	1.90	V
	digital	VDDLx	DV_DD		1.10	1.20	1.30	V
		XHS XVS XCLR INCK XMASTER	VIH	XVS / XHS	0.8OV _{DD}	I	_	>
Digital input	Digital input voltage		VIL	Slave Mode	_		0.20V _{DD}	٧
		DLOP [A:H] DLOM [A:H]	VCM	Low voltage LVDS	~9 <u>·</u>	OV _{DD} /2	_	V
Digital output voltage		DLCKP DLCKM VOD XHS XVS		Low voltage LVDS (Termination resistance: 100 Ω)	100	150	220	mV
				XVS/XHS	OV _{DD} -0.4		_	V
		SDO TOUT	VOL	Master Mode	_	_	0.4	V



Current Consumption

			Ту	/p.	Ma		
Item	pin	Symbol	Standard luminous intensity	Saturated luminous intensity	Standard luminous intensity	Saturated luminous intensity	Unit
Operating current	VDDH	IAV _{DD}	85	85	140	140	mA
Low voltage LVDS serial 4 ch	VDDM	IOV_{DD}	15	15	25	25	mA
All pixel scan mode	VDDL	IDV_DD	80	100	135	170	mA
Operating current	VDDH	IAV _{DD}	85	85	140	140	mA
MIPI CSI-2 / 4 lane 12 bit 60 frame / s	VDDM	IOV_{DD}	1	1	5	5	mA
All pixel scan mode	VDDL	IDV_DD	92	112	155	185	mA
	VDDH	IAV _{DD} _STB	-	_	0	.1	mA
Standby current	VDDM	IOV _{DD} _STB	-	_	0.1		mA
	VDDL	IDV _{DD} _STB	_	_	1	4	mA

Operating current: (Typ.) Supply voltage3.3 V / 1.8 V / 1.2 V, Tj = 25° C

(Max.) Supply voltage3.45 V / 1.9 V / 1.3 V, Tj = 60 °C, worst state of internal circuit

operating current consumption,

Standby: (Max.) Supply voltage3.45 V / 1.9 V / 1.3 V, Tj = 60 °C, INCK: 0 V,

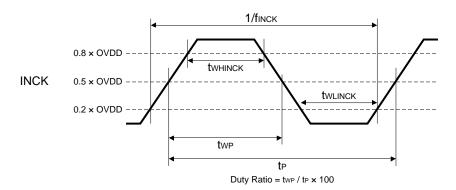
The device in the light-obstructed state.

Standard luminous intensity: luminous intensity at 1/3 of the sensor saturated. Saturated luminous intensity: luminous intensity when the sensor is saturated.

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AC Characteristics

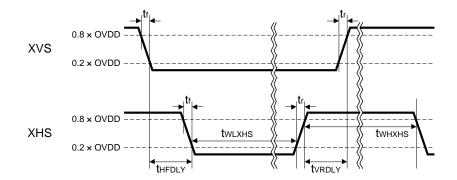
Master Clock Waveform (INCK)



Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
INCK clock frequency	f _{INCK}	f _{INCK} × 0.96	f _{INCK}	f _{INCK} × 1.02	MHz	f _{INCK} = 37.125 MHz, 74.25 MHz
INCK Low level pulse width	t _{WLINCK}	4		_	ns	f _{INCK} = 37.125 MHz, 74.25 MHz
INCK High level pulse width	twHINCK	4	_	- >	ns	f _{INCK} = 37.125 MHz, 74.25 MHz
INCK clock duty	_	45.0	50.0	55.0	%	Define with 0.5 × OV _{DD}
*The INCK fluctuation affects		Tale.	OUP			

^{*}The INCK fluctuation affects the frame rate.

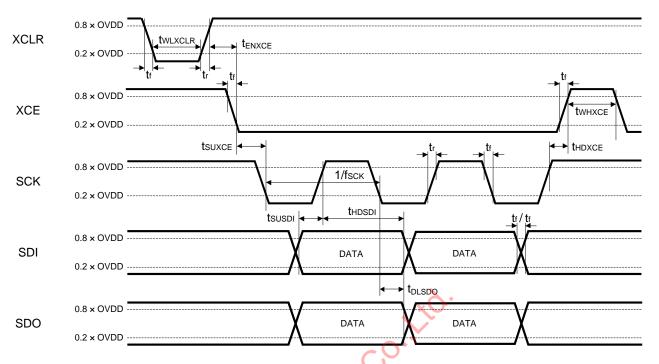
XVS / XHS Input Characteristics In Slave Mode (DMODE pin = High)



Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
XHS Low level pulse width	t _{WLXHS}	4 / f _{INCK}	_	_	ns	_
XHS High level pulse width	twnxns	4 / f _{INCK}	_	_	ns	_
XVS - XHS fall width	t _{HFDLY}	1 / f _{INCK}	_	_	ns	_
XHS - XVS rise width	t _{VRDLY}	1 / f _{INCK}	- x	> . –	ns	_
XVS, XHS rise time	t _r		-\	5	ns	20 % to 80 %
XVS, XHS fall time	t _f	- (- <u>O-</u> "	5	ns	80 % to 20 %
ROM	ertex	HOUN				

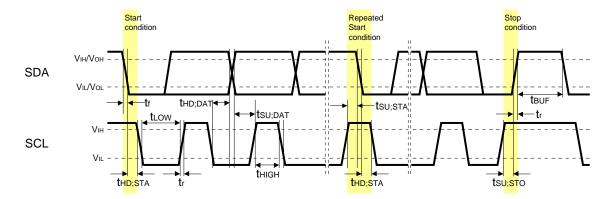
Serial Communication

4-wire



Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
SCK clock frequency	f _{SCK}		77	13.5	MHz	_
XCLR Low level pulse width	t _{WLXCLR}	4/finck	_	_	ns	_
XCE effective margin	t _{ENXCE}	20	_	_	μs	_
XCE input set-up time	t _{SUXCE}	20		ı	ns	-
XCE input hold time	t _{HDXCE}	20			ns	
XCE High level pulse width	twhxce	20		ı	ns	1
SDI input set-up time	t _{SUSDI}	10			ns	
SDI input hold time	t _{HDSDI}	10	_	_	ns	_
SDO output delay time	t _{DLSDO}	0		25	ns	Output load capacitance: 20 pF
Rise time of each input signal	t _r		_	5	ns	20 % to 80 %
Fall time of each input signal	t _f	_	_	5	ns	80 % to 20 %

 I^2C



I²C Specification

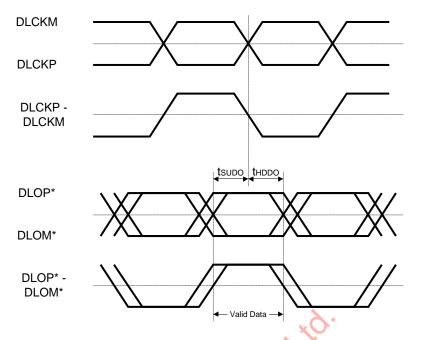
Item	Symbol	Min.	Тур.	Max.	Unit	条件
Low level input voltage	VIL	-0.3		0.3 × OVDD	V	_
High level input voltage	VIH	0.7 × OVDD	_	1.9	V	_
Low level input voltage	VOL	0	_	0.2 × OVDD	V	OVDD < 2 V, Sink 3 mA
High level input voltage	VOH	0.8 × OVDD	_		V	_
Output fall time	tof	_	- (250	ns	Load 10 pF – 400 pF, 0.7 × OVDD – 0.3 × OVDD
Input current	li	-10	· 1	10	μΑ	0.1 × OVDD – 0.9 × OVDD
Capacitance for SCK (SCL) /SDI (SDA)	Ci		10	10	pF	_

I²C AC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit
SCL clock frequency	f _{SCL}	0	_	400	kHz
Hold time (Start Condition)	t _{HD;STA}	0.6	_	_	μs
Low period of the SCL clock	t _{LOW}	1.3	_	_	μs
High period of the SCL clock	t _{HIGH}	0.6	_	_	μs
Set-up time (Repeated Start Condition)	t _{SU;STA}	0.6	_	_	μs
Data hold time	t _{HD;DAT}	0	_	0.9	μs
Data set-up time	t _{SU;DAT}	100	_	_	ns
Rise time of both SDA and SCL signals	t _r	_	_	300	ns
Fall time of both SDA and SCL signals	t _f	_	_	300	ns
Set-up time (Stop Condition)	t _{SU;STO}	0.6	_		μs
Bus free time between a STOP and START Condition	t _{BUF}	1.3	_	_	μs

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Low Voltage LVDS DDR Output



(Output load capacitance: 8 pF)

Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
DLCKP/DLCKM clock duty	_	40	50	60	%	DLCK = 222.75 MHz (Max.)
DLO set-up time	t _{SUDO}	400	JAK.	_	ps	Data Rate 222.75 MHz DDR
DLO hold time	t _{HDDO}	400	0_	_	ps	Data Rate 222.75 MHz DDR

I/O Equivalent Circuit Diagram

 $\hfill\square$: External pin

Symbol	Equivalent circuit	Symbol	Equivalent circuit
INCK	VSSMIF	XVS XHS	Digital I/O VSSMIF
XCLR XCE XMASTER OMODE XTRIG	Digital input VSSMIF	SDI SCK	Digital WO 7/1/ VSSMIF
SDO	Digital output VSSMIF	S	
VCPFR VCPST VRLFR VRLST	Analog VSSHCP VSSHCP (VCPFR, VCPST) VSSHPX (VRLFR, VCPST)	VLOADLM VBGR	Analog VSSHPX(VLOADLM) VSSHPX(VLOADLM) VSSHAN(VBGR)
DMOPX DMONX DMCKP DMCKN	Data output VSSLIF	DLOPy DLOMy DLCKP DLCKM TOUT	Data output VSSMIF

Spectral Sensitivity Characteristics

(Excludes lens characteristics and light source characteristics.)

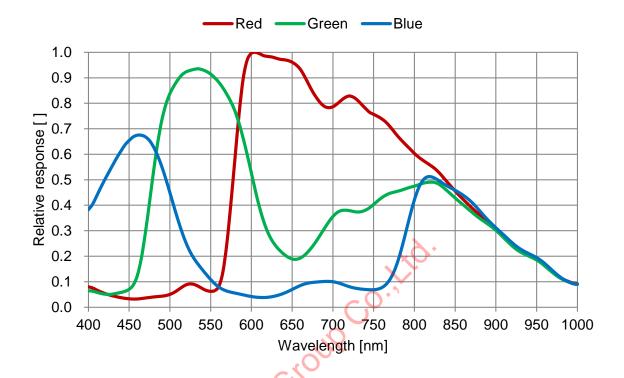


Image Sensor Characteristics

 $(AV_{DD} = 3.3 \text{ V}, OV_{DD} = 1.8 \text{ V}, DV_{DD} = 1.2 \text{ V}, Tj = 60 ^{\circ}C, All-pixel scan mode, 12 bit 30 frame/s, Gain: 0 dB)$

Item		Symbol	Min.	Тур.	Max.	Unit	Measurement method	Remarks
		Ø	6472 (2040)	7456 (2350)	1	Digit (mV)	1	1/30 s storage 12 bit converted value HCG mode
G sensitivity		0	3236 (1020)	3728 (1175)	1	Digit (mV)	ı	1/30 s storage 12 bit converted value LCG mode
Sensitivity	R/G	RG	0.56	_	0.71	_	2	_
ratio	B/G	BG	0.31	_	0.46	_	2	_
Saturation sign	nal	Vsat	3839 (1210)	1	1	Digit (mV)	3	12 bit converted value LCG mode
Video signal sh	Video signal shading		1	1	25	%	4	_
Vertical line		VL	I	I	90	μ۷	5	12 bit converted value HCG mode
Dark signal		Vdt	1	1	0.48 (0.15)	Digit (mV)	6	1/30 s storage 12 bit converted value LCG mode
Dark signal shading		ΔVdt	_	SIC	0.63 (0.2)	Digit (mV)	7	1/30 s storage 12 bit converted value LCG mode
Conversion eff	Conversion efficiency ratio		1.8	2	2.2	_	8	HCG mode / LCG mode

Note)

- 1. Converted value into mV using 1Digit = 0.3151 mV for 12-bit output and 1Digit = 1.2605 mV for 10-bit output.
 - 2. The video signal shading is the measured value in the wafer status (including color filter) and does not include characteristics of the seal glass.
 - 3. The characteristics above apply to effective pixel area that is shown below.

Zone Definition

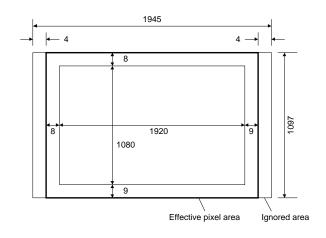


Image Sensor Characteristics Measurement Method

Measurement Conditions

1. In the following measurements, the device drive conditions are at the typical values of the bias conditions and clock voltage conditions.

2. In the following measurements, spot pixels are excluded and, unless otherwise specified, the optical black (OB) level is used as the reference for the signal output, which is taken as the value of the Gr / Gb channel signal output or the R / B channel signal output of the measurement system.

Color Coding of Physical Pixel Array

The primary color filters of this image sensor are arranged in the layout shown in the figure below. Gr and Gb represent the G signal on the same line as the R and B signals, respectively. The Gb signal and B signal lines and the R signal and Gr signal lines are output successively.

Gb	В	Gb	В
R	Gr	R	Gr
Gb	В	Gb	В
R	Gr	R	Gr

Color Coding Diagram

Definition of standard imaging conditions

◆ Standard imaging condition I:

Use a pattern box (luminance: 706 cd/m², color temperature of 3200 K halogen source) as a subject. (Pattern for evaluation is not applicable.) Use a testing standard lens with CM500S (t = 1.0 mm) as an IR cut filter and image at F5.6. The luminous intensity to the sensor receiving surface at this point is defined as the standard sensitivity testing luminous intensity.

- Standard imaging condition II:
 - Image a light source (color temperature of 3200 K) with a uniformity of brightness within 2 % at all angles. Use a testing standard lens with CM500S (t = 1.0 mm) as an IR cut filter. The luminous intensity is adjusted to the value indicated in each testing item by the lens diaphragm.
- ◆ Standard imaging condition III:

Image a light source (color temperature of 3200 K) with a uniformity of brightness within 2 % at all angles. Use a testing standard lens (exit pupil distance - 30 mm) with CM500S (t = 1.0 mm) as an IR cut filter. The luminous intensity is adjusted to the value indicated in each testing item by the lens diaphragm.

Measurement Method

1. Sensitivity

Set the measurement condition to the standard imaging condition I. After setting the electronic shutter mode with a shutter speed of 1/100 s, measure the Gr and Gb signal outputs (VGr, VGb) at the center of the screen, and substitute the values into the following formula.

$$Sg = (VGr + VGb) / 2 \times 100/30 [mV]$$

2. Sensitivity ratio

Set the measurement condition to the standard imaging condition II. After adjusting the average value of the Gr and Gb signal outputs to 1175 mV, measure the R signal output (VR [mV]), the Gr and Gb signal outputs (VGr, VGb [mV]) and the B signal output (VB [mV]) at the center of the screen in frame readout mode, and substitute the values into the following formulas.

3. Saturation signa I

Set the measurement condition to the standard imaging condition II. After adjusting the luminous intensity to 20 times the intensity with the average value of the Gr and Gb signal outputs, 500 mV, measure the average values of the Gr, Gb, R and B signal outputs.

4. Video signal shading

Set the measurement condition to the standard imaging condition III. With the lens diaphragm at F2.8, adjust the luminous intensity so that the average value of the Gr and Gb signal outputs is 1175 mV. Then measure the maximum value (Gmax [mV]) and the minimum value (Gmin [mV]) of the Gr and Gb signal outputs, and substitute the values into the following formula.

$$SH = (Gmax - Gmin) / 1175 \times 100 [\%]$$

Vertical line

With the device junction temperature of 60 °C and the device in the light-obstructed state, calculates each average output of Gr, Gb, R and B on respective columns. Calculates maximum value of difference with adjacent column on the same color (VL $[\mu V]$).

6. Dark signal

With the device junction temperature of 60 °C and the device in the light-obstructed state, divide the output difference between 1/30 s integration and 1/300 s integration by 0.9, and calculate the signal output converted to 1/30 s integration. Measure the average value of this output (Vdt [mV]).

7. Dark signal shading

After the measurement item 5, measure the maximum value (Vdmax [mV]) and the minimum value (Vdmin [mV]) of the dark signal output, and substitute the values into the following formula.

$$\Delta Vdt = Vdmax - Vdmin [mV]$$

8. Conversion efficiency ratio

Set the measurement condition to the standard imaging condition II. After adjusting the average value of the Gr and Gb signal outputs to 420 mV at the LCG mode, measure the average values of Gr and Gb signal output and calculate the ratio between HCG mode and LCG mode.

Setting Registers Using Serial Communication

This sensor can write and read the setting values of the various registers shown in the Register Map by 4-wire serial communication and I^2C communication. See the Register Map for the addresses and setting values to be set. Because the two communication systems are judged at the first communication, once they are judged, the communication cannot be switched until sensor reset. The pin for 4-wire serial communication and I^2C communication is shared, so the external pin XCE must be fixed to power supply side when using I^2C communication.

Description of Setting Registers (4-wire)

The serial data input order is LSB-first transfer. The table below shows the various data types and descriptions.

Serial Data Transfer Order

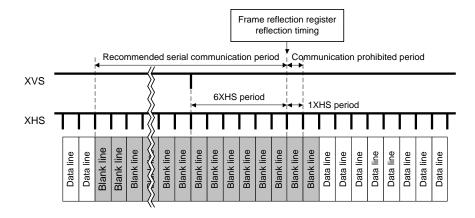
Chip ID	Start address	Data	Data	Data	
(8 bit)	(8 bit)	(8 bit)	(8 bit)	(8 bit)	(8 bit)

Type and Description

Туре	Description
Chip ID	02h: Write to the Chip ID = 02h register 03h: Write to the Chip ID = 03h register 04h: Write to the Chip ID = 04h register 05h: Write to the Chip ID = 05h register 82h: Read from the Chip ID = 02h register 83h: Read from the Chip ID = 03h register 84h: Read from the Chip ID = 04h register 85h: Read from the Chip ID = 05h register
Address	Designate the address according to the Register Map. When using a communication method that designates continuous addresses, the address is automatically incremented from the previously transmitted address.
Data	Input the setting values according to the Register Map.

Register Communication Timing (4-wire)

Perform serial communication in sensor standby mode or within in the 6XHS period after the falling edge of XVS from the blanking line output start time after valid line of one frame is finished. For the registers marked "V" in the item of Reflection timing, when the communication is performed in the communication period shown in the figure below they are reflected by frame reflection timing. For the registers noted "Immediately" in the item of Reflection timing, the settings are reflected when the communication is performed. (For the immediate reflection registers other than STANDBY, REGHOLD, XMSTA, SW_RESET, XVSOUTSEL [1:0] and XHSOUTSEL [1:0], set them in sensor standby state.) About REGHOLD register only, communication period is different than the other registers. For details, see section "Register Hold Settings".



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Register Write and Read (4-wire)

Follow the communication procedure below when writing registers.

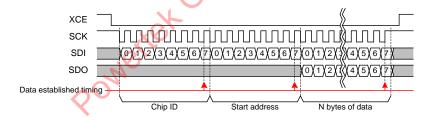
1. Set XCE Low to enable the chip's communication function. Serial data input is executed using SCK and SDI.

- 2. Transmit data in sync with SCK 1 bit at a time from the LSB using SDI. Transfer SDI in sync with the falling edge of SCK. (The data is loaded at the rising edge of SCK.)
- 3. Input Chip ID (CID = 02h or 03h or 04h or 05h) to the first byte. If the Chip ID differs, subsequent data is ignored.
- 4. Input the start address to the second byte. The address is automatically incremented.
- 5. Input the data to the third and subsequent bytes. The data in the third byte is written to the register address designated by the second byte, and the register address is automatically incremented thereafter when writing the data for the fourth and subsequent bytes. Normal register data is loaded to the inside of the sensor and established in 8-bit units.
- 6. The register values starting from the register address designated by the second byte are output from the SDO pin. The register values before the write operation are output. The actual register values are the input data.
- 7. Set XCE High to end communication.

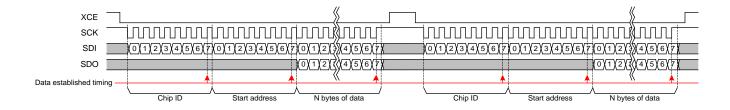
Follow the communication procedure below when reading registers.

- 1. Set XCE Low to enable the chip's communication function. Serial data input is executed using SCK and SDI.
- 2. Transmit data in sync with SCK 1 bit at a time from the LSB using SDI. Transfer SDI in sync with the falling edge of SCK. (The data is loaded at the rising edge of SCK.)
- 3. Input Chip ID (CID = 82h or 83h or 84h or 85h) to the first byte. If the Chip ID differs, subsequent data is ignored.
- 4. Input the start address to the second byte. The address is automatically incremented.
- 5. Input data to the third and subsequent bytes. Input dummy data in order to read the registers. The dummy data is not written to the registers. To read continuous data, input the necessary number of bytes of dummy data.
- 6. The register values starting from the register address designated by the second byte are output from the SDO pin. The input data is not written, so the actual register values are output.
- 7. Set XCE High to end communication.

Note) When writing data to multiple registers with discontinuous addresses, access to undesired registers can be avoided by repeating the above procedure multiple times.



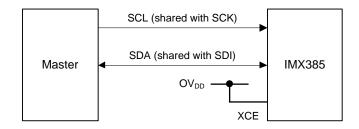
Serial Communication (Continuous Address)



Serial Communication (Discontinuous Address)

Description of Setting Registers (I²C)

The serial data input order is MSB-first transfer. The table below shows the various data types and descriptions.



Pin connection of serial communication

SLAVE Address

MSB									
0	0	1	1	0	1	0	R/W		

^{*} R/W is data direction bit

R/W

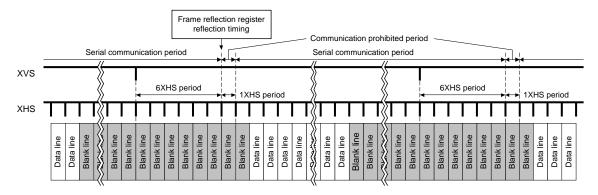
R / W bit	Data direction
0	Write (Master → Sensor)
1	Read (Sensor → Master)

I²C pin description

Symbol	Pin No.	Remarks
SCL (Common to SCK)	E5	Serial clock input
SDA (Common to SDI)	E6 🗶	Serial data communication

Register Communication Timing (I²C)

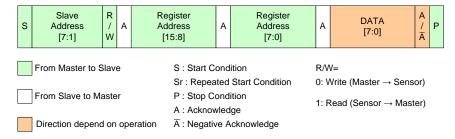
In I²C communication system, communication can be performed excluding during the period when communication is prohibited from the falling edge of XVS to 6H after (1H period). For the registers marked "V" in the item of Reflection timing, when the communication is performed in the communication period shown in the figure below they are reflected by frame reflection timing. For the registers noted "Immediately" in the item of Reflection timing, the settings are reflected when the communication is performed. (For the immediate reflection registers other than STANDBY, REGHOLD, XMSTA, SW_RESET, XVSOUTSEL [1:0] and XHSOUTSEL [1:0], set them in sensor standby state.) Using REG_HOLD function is recommended for register setting using I²C communication. For REG_HOLD function, see "Register Hold Setting" in "Description of Various Functions". About REGHOLD register only, communication period is different than the other registers. For details, see section "Register Hold Settings".



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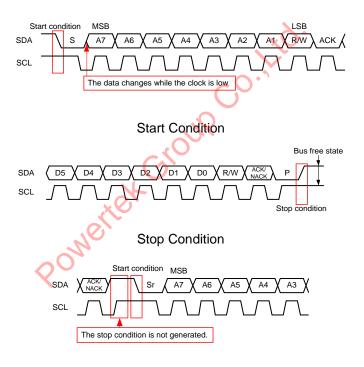
Communication Protocol

I²C serial communication supports a 16-bit register address and 8-bit data message type.



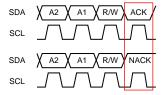
Communication Protocol

Data is transferred serially, MSB first in 8-bit units. After each data byte is transferred, A (Acknowledge) / \overline{A} (Negative Acknowledge) is transferred. Data (SDA) is transferred at the clock (SDL) cycle. SDA can change only while SCL is Low, so the SDA value must be held while SCL is High. The Start condition is defined by SDA changing from High to Low while SCL is High. When the Stop condition is not generated in the previous communication phase and Start condition for the next communication is generated, that Start condition is recognized as a Repeated Start condition.



Repeated Start Condition

After transfer of each data byte, the Master or the sensor transmits an Acknowledge / Negative Acknowledge and release (does not drive) SDA. When Negative Acknowledge is generated, the Master must immediately generate the Stop Condition and end the communication.



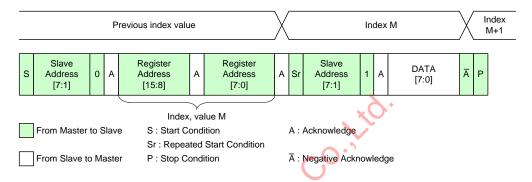
Acknowledge and Negative Acknowledge

Register Write and Read (I²C)

This sensor corresponds to four read modes and the two write modes.

Single Read from Random Location

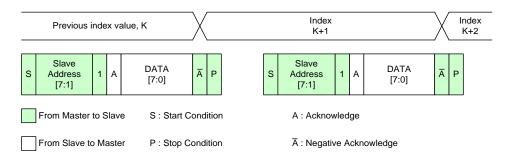
The sensor has an index function that indicates which address it is focusing on. In reading the data at an optional single address, the Master must set the index value to the address to be read. For this purpose it performs dummy write operation up to the register address. The upper level of the figure below shows the sensor internal index value, and the lower level of the figure shows the SDA I/O data flow. The Master sets the sensor index value to M by designating the sensor slave address with a write request, then designating the address (M). Then, the Master generates the start condition. The Start Condition is generated without generating the Stop Condition, so it becomes the Repeated Start Condition. Next, when the Master sends the slave address with a read request, the sensor outputs an Acknowledge immediately followed by the index address data on SDA. After the Master receives the data, it generates a Negative Acknowledge and the Stop Condition to end the communication.



Single Read from Random Location

Single Read from Current Location

After the slave address is transmitted by a write request, that address is designated by the next communication and the index holds that value. In addition, when data read/write is performed, the index is incremented by the subsequent Acknowledge/Negative Acknowledge timing. When the index value is known to indicate the address to be read, sending the slave address with a read request allows the data to be read immediately after Acknowledge. After receiving the data, the Master generates a Negative Acknowledge and the Stop Condition to end the communication, but the index value is incremented, so the data at the next address can be read by sending the slave address with a read request.

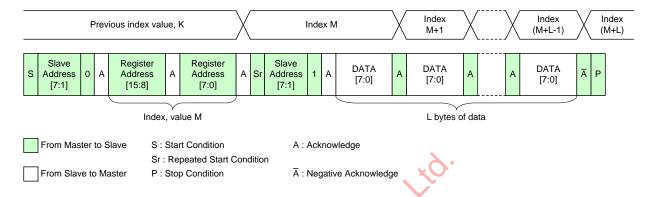


Single Read from Current Location



Sequential Read Starting from Random Location

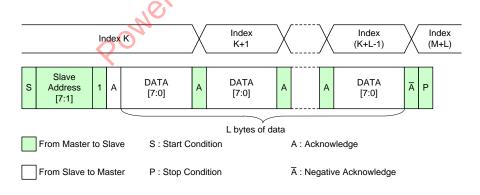
In reading data sequentially, which is starting from an optional address, the Master must set the index value to the start of the addresses to be read. For this purpose, dummy write operation includes the register address setting. The Master sets the sensor index value to M by designating the sensor slave address with a read request, then designating the address (M). Then, the Master generates the Repeated Start Condition. Next, when the Master sends the slave address with a read request, the sensor outputs an Acknowledge followed immediately by the index address data on SDA. When the Master outputs an Acknowledge after it receives the data, the index value inside the sensor is incremented and the data at the next address is output on SDA. This allows the Master to read data sequentially. After reading the necessary data, the Master generates a Negative Acknowledge and the Stop Condition to end the communication.



Sequential Read Starting from Random Location

Sequential Read Starting from Current Location

When the index value is known to indicate the address to be read, sending the slave address with a read request allows the data to be read immediately after the Acknowledge. When the Master outputs an Acknowledge after it receives the data, the index value inside the sensor is incremented and the data at the next address is output on SDA. This allows the Master to read data sequentially. After reading the necessary data, the Master generates a Negative Acknowledge and the Stop Condition to end the communication.

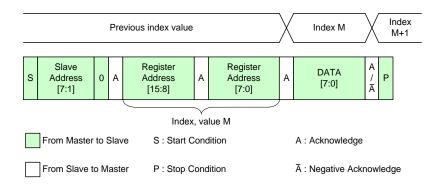


Sequential Read Starting from Current Location



Single Write to Random Location

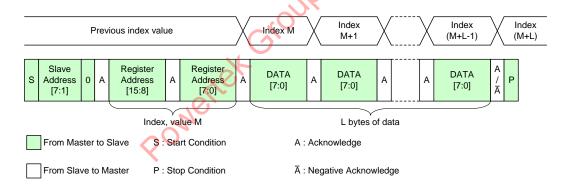
The Master sets the sensor index value to M by designating the sensor slave address with a write request, and designating the address (M). After that the Master can write the value in the designated register by transmitting the data to be written. After writing the necessary data, the Master generates the Stop Condition to end the communication.



Single Write to Random Location

Sequential Write Starting from Random Location

The Master can write a value to register address M by designating the sensor slave address with a write request, designating the address (M), and then transmitting the data to be written. After the sensor receives the write data, it outputs an Acknowledge and at the same time increments the register address, so the Master can write to the next address simply by continuing to transmit data. After the Master writes the necessary number of bytes, it generates the Stop Condition to end the communication.



Sequential Write Starting from Random Location

Register Map

This sensor has a total of 1024 bytes (256×4) of registers, composed of registers with addresses 00h to FFh that correspond to Chip ID = 02h (write mode) / 82h (read mode), Chip ID = 03h (write mode) / 83h (read mode), Chip ID = 04h (write mode) / 84h (read mode), and Chip ID = 05h (write mode) / 85h (read mode). Use the initial values for empty address. Some registers must be change from the initial values, so the sensor control side should be capable of setting 1024 bytes.

The values must be changed from the default value, so initial setting after reset is required after power-on. There are two different register reflection timing. Values are reflected immediately after writing to register noted as "Immediately", or at the frame reflection register reflection timing described in the item of "Register Communication Timing" in the section of "Setting Registers Using Serial Communication" for registers noted as "V" in the Reflection timing column of the Register Map. For the immediate reflection registers other than belows, set them in sensor standby state.

STANDBY REGHOLD XMSTA SW_RESET XVSOUTSEL [1:0] XHSOUTSEL [1:0]

Do not perform communication to addresses not listed in the Register Map. Doing so may result in operation errors. However, other registers that requires communication to address not listed above may be added, so addresses up to FEh should be supported for CID = 02h, 03h, 04h and 05h. (In I²C communication, address; 3000h to 30FFh, 3100h to 31FFh, 3200h to 32FFh, 3300h to 33FFh)

* For the register that is writing " * " to the setting value in description (Indicated by red letter), change the value from the default value after the reset.

Registers corresponding to Chip ID = 02h in Write mode. (Read: Chip ID = 82h)

Add	dress					t value	Reflection
	2	bit	Register name	Description	Ву		timing
4-wire	I ² C				-	-	9
			07111711	Standby			
		0	STANDBY		1h		Immediately
		1	_		0h	ister address I h Oh Oh Oh Oh Oh Oh Oh Oh Oh	_
		2	_	Fixed to "0h"	0h		_
00h	3000h	3	_		0h	01h	_
		4	_	Fixed to "0h"	0h	O1h O1h	_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
				Register hold			
		0	DECLIOI D	(Function not to update V reflection register)	O.L		
		0	STANDBY Standby 0: Operating 1: Stand Fixed to "0h" Register hold (Function not to update V 0: Invalid 1: Valid Fixed to "0h" Setting of master mode operating 1: Master mode operating 1: Reset Fixed to "0h" Fixed to "0h" Fixed to "0h" Fixed to "0h" Setting of master mode operating 1: Reset Fixed to "0h" Fixed to "0h"		Un		Immediately
				1: Valid	By register By address In In In In In In In		
		1	_	Fixed to "0h"	0h		_
01h	3001h	2	_	Fixed to "0h"	By register address 1h	00h	_
		3	_	Fixed to "0h"	0h		_
		4	_	Fixed to "0h"	0h		_
		5	_	Fixed to "0h"	0h	By address O1h O0h	_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
				Setting of master mode operation			
		0			1h		Immediately
				1: Master mode operation stop		00h	
		1	_	Fixed to "0h"	0h		_
0.01-	00001	2	_	Fixed to "0h"	0h	O1h O1h O1h	_
02h	3002h	3	_	Fixed to "0h"	0h		_
		4	_	Fixed to "0h"	0h		_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	- 0	Fixed to "0h"	0h		_
			\Diamond	Software reset			
		0	SW_RESET	0: Operating	0h		Immediately
		1	_	Fixed to "0h"	0h		
026	20026	2	_	Fixed to "0h"	0h	By address O1h O0h O0h O0h	
03h	3003h	3	_		0h	UUII	_
		4	_	Fixed to "0h"	0h		_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
04h	3004h	[7:0]	_	Do not rewrite	_	_	_

Address					Default value after reset		Reflection
4-wire	I ² C	bit	Register name	Description	By register	By address	timing
05h	3005h	0	ADBIT	AD conversion bits setting 0: 10 bit, 1: 12 bit	1h	01h	V
		1	_	Fixed to "0h"	0h		_
		2	_	Fixed to "0h"	0h		_
		3	_	Fixed to "0h"	0h		_
		4	_	Fixed to "0h"	0h		_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
06h	3006h	[7:0]	_	Do not rewrite	_	_	_
	3007h	0	VREVERSE	Vertical (V) direction readout inversion control 0: Normal, 1: Inverted	0h	- 00h	V
		1	HREVERSE	Horizontal (H) direction readout inversion control 0: Normal, 1: Inverted	0h		V
07h		2	_	Fixed to "0h"	0h		_
		3	_	Fixed to "0h"	0h		_
		4 5 6 7	WINMODE	0h: All-pixel scan mode 4h: Window cropping mode Others: Setting prohibited	0h		V
08h	3008h	[7:0]	_	Do not rewrite	_	_	_
09h	3009h	0	FRSEL [1:0]	Frame rate (Data rate) setting For details, see the register setting list in each operation mode.	1h	01h	٧
		2	_	Fixed to "0h"	0h		_
		3	_	Fixed to "0h"	0h		_
		4	FDG_SEL	Conversion gain switching 0: LCG Mode 1: HCG Mode	0h		V
		5	0	Fixed to "0h"	0h		_
		6		Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_

Address					Default value after reset		Reflection
4-wire	I ² C	bit	Register name	Description	By register	By address	timing
		0		LSB			
0Ah	300Ah	1				F0h	
		2		Black level offset value setting	0F0h		
		3	BLKLEVEL [8:0]				
							V
		5					
		6					
		7					
	300Bh	0		MSB	01	00h	
0Bh		1	_	Fixed to "0h"	0h		_
		2	_	Fixed to "0h"	0h		_
		3	_	Fixed to "0h"	0h		
		4	_	Fixed to "0h" Fixed to "0h"	0h		
		5 6	-	Fixed to "0h"	0h 0h		_
		7	-	Fixed to "0h"	0h		_
0Ch	300Ch	[7:0]	_	rixed to on	OH		_
to	to	to	_	Do not rewrite	_	_	_
11h	3011h	[7:0]		Do not rewrite			
12h	3012h	[7:0]	_	Fixed to "2Ch" *	F0h	F0h	_
13h	3013h	[7:0]	_	Fixed to "01h" *	00h	00h	_
	3014h	0		LSB	000h	00h	
		1					
		2					
14h		3		Gain setting			
		4		(0.0 dB to 72.0 dB / 0.1 dB step)			V
		5		(Refer to Address 16h about detail of Reflection Timing)			
		6 7		renection riming)			
		0		,Xe			
15h	3015h	1		MSB		00h	
		2		Fixed to "0h"	0h		_
		3	-20,	Fixed to "0h"	0h		_
		4		Fixed to "0h"	0h		_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
16h	3016h			Setting of Gain Reflection Timing at		08h	
		[7:0] GAINDLY[7:0]		Normal Mode			
				08h: Gain reflect at the frame			
			GAINDLY[7:0]	09h: Gain reflect at the next frame	08h		V
			(Same timing as SHS1 reflecting				
				output)			
471	2047	[7:0]		Others: Setting prohibited			
17h	3017h	[7:0]	_	Do not rewrite		_	_

Add	Iress				Defaul after	t value reset	Reflection
4-wire	I ² C	bit	Register name	Description	By register	By address	timing
18h	3018h	0 1 2 3 4 5 6		LSB When sensor master mode vertical span setting. (Number of operation lines count	J	65h	
19h	19h 3019h		VMAX [16:0]	from 1) For details, see the item of "Slave Mode and Master Mode" in the section of "Description of Various Functions"	00465h	04h	V
1Ah	301Ah	0 1 2 3 4 5 6		MSB Fixed to "0h"	Oh Oh Oh Oh Oh Oh Oh Oh	00h	
1Bh	301Bh	0 1 2 3 4 5 6		When sensor master mode horizontal span setting. (Number of operation clocks count from 1) For details, see the item of "Slave Mode	0898h	98h	V
1Ch	6 — 7 —		- -	and Master Mode" in the section of "Description of Various Functions" MSB Fixed to "0h" Fixed to "0h"	Oh Oh	08h	
1Dh to 1Fh	301Dh to 301Fh	7 — Oh [7:0] to —		Do not rewrite	_	_	_

Ado	Iress	la ia	Degister name	Description	Defaul after	t value reset	Reflection
4-wire	I ² C	bit	Register name	Description	Ву	Ву	timing
1 1	. 0				register	address	
		0		LSB			
		1					
		2					
20h	3020h	3				00h	
2011	302011	4				OOH	
		5					
		7		Character and times and discrete			
		0	SHS1 [16:0]	Storage time adjustment	00000h		V
		1		Designated in line units.			
		2					
		3				00h	
21h	3021h	4					
		5					
		6					
		7					
		0		MSB			
		1	_	Fixed to "0h"	0h		_
		2	_	Fixed to "0h"	0h		_
0.01	00001	3	_	Fixed to "0h"	0h	0.01-	_
22h	3022h	4	_	Fixed to "0h"	0h	00h	_
		5	_	Fixed to "0h"	0h		_
	,	6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_

Add	Iress	L. 11	De sister neme	Description	Defaul after	t value reset	Reflection
4-wire	I ² C	bit	Register name	Description	By register	By address	timing
23h to 35h	3023h to 3035h	[7:0] to [7:0]	_	Do not rewrite	_	_	_
36h	3036h	0	WINWV_OB [4:0]	LSB In window cropping mode Cropping size designation (Vertical direction effective OB) MSB Fixed to "0h" Fixed to "0h" Fixed to "0h"	10h Oh Oh Oh	v	
37h	3037h	[7:0]	_	Do not rewrite	_	_	_
38h	3038h	0 1 2 3 4 5 6 7	WINPV [10:0]	In window cropping mode Designation of upper left coordinate for cropping position (Vertical position)	000h	00h	V
39h	3039h	0 1 2 3 4 5 6		MSB Fixed to "0h"	Oh Oh Oh Oh	00h	
3Ah	303Ah	0 1 2 3 4		In window cropping mode Cropping size designation (Vertical direction)	3D1h	D1h	V
3Bh	303Bh	0 1 2 3 4 5 6		MSB Fixed to "0h"	Oh Oh Oh Oh Oh	03h	

Add	Iress					t value reset	Reflection	
4-wire	I ² C	bit	Register name	Description	By register	By address	timing	
		0		LSB	3 3 3 3			
3Ch	303Ch	2 3 4 5 6 7	WINPH [10:0]	In window cropping mode Designation of upper left coordinate for cropping position (Horizontal position) Set to become the multiple of four	000h	00h	V	
		0 1 2		MSB				
		3	_	Fixed to "0h"	0h		_	
3Dh	303Dh	4	_	Fixed to "0h"	0h	00h	_	
		5	_	Fixed to "0h"	0h		_	
		6	_	Fixed to "0h"	0h		_	
		7	_	Fixed to "0h"	0h		_	
254	303Eh	0 1 2 3		LSB .	5	1Ch		
3Eh	303EII	4 5 6 7	WINWH [10:0]	In window cropping mode Cropping size designation (Horizontal direction) Set to become the multiple of four	51Ch	1Ch	V	
		0 1 2		MSB COLUMN TO THE COLUMN TO TH		Oh		
3Fh	303Fh	3	_	Fixed to "0h"	0h	05h	_	
		4	_	Fixed to "0h"	0h			
		5	_	Fixed to "0h"	0h		_	
		6	_	Fixed to "0h"	0h			
	25.11	7	_	Fixed to "0h"	0h		_	
40h to 43h	3040h to 3043h	[7:0] to [7:0]	_	Do not rewrite	_	_	_	
		0	ODBIT	Number of output bit setting 0: 10 bit, 1: 12 bit * In CSI-2 mode (OMODE = Low), Fixed to "1h".	1h		Immediately	
		1	_	Fixed to "0h"	0h		_	
		2	_	Fixed to "0h"	0h		_	
		3	_	Fixed to "0h"	0h		_	
44h	3044h	4 5		Output interface selection (In CIS-2 mode, no concern. Set interface with ChipID:05h)		01h		
		6	OPORTSEL [3:0]	0h: CSI-2 mode Dh: LVDS 2 ch Eh: LVDS 4 ch	0h		Immediately	
		7		Fh: LVDS 8 ch Others: Setting prohibited				

Add	Iress		Б	5		t value reset	Reflection
4-wire	I ² C	bit	Register name	Description	By register	By address	timing
45h	3045h	[7:0]	_	Do not rewrite	_	_	_
		0	_	Fixed to "0h"	0h		_
		1		Fixed to "0h"	0h		timing
		2	_	Fixed to "0h"	0h		
		3	_	Fixed to "0h"	0h		_
46h	3046h	4		XVS pulse width setting in master mode.		00h	
		-	XVSLNG [1:0]	(In slave mode, setting is invalid.)	0h		Immediately
		5		0: 1H, 1: 2H, 2: 4H, 3: 8H			
		6		Fixed to "0h"	0h		_
		7	1	Fixed to "0h"	0h		_
		0	_	Fixed to "0h"	0h		_
		1	<u> </u>	Fixed to "0h"	0h		_
		2	_	Fixed to "0h"	0h		_
		3	<u> </u>	Fixed to "1h"	1h		_
47h	3047h	4		XHS pulse width setting in master mode.		08h	
		_	XHSLNG [1:0]	(In slave mode, setting is invalid.)	0h		Immediately
				0: Min. to 3: Max.			
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
48h	3048h	[7:0]	_	Do not rewrite	_	_	_
		0		XVS pin setting in master mode.			
				0: Fixed to High	0h		Immediately
		1	[]	2: VSYNC output			
				Others: Setting prohibited			
		2		XHS pin setting in master mode			
49h	3049h	9h		0: Fixed to High 2: HSYNC output	0h	00h	Immediately
		3		Others: Setting prohibited			
		4	_	Fixed to "0h"	0h		
		5		Fixed to "0h"	0h		
		6		Fixed to "0h"	0h		
		7		Fixed to "0h"	0h		
4Ah	304Ah	[7:0]		- MOG 10 011	OII		
to	to	to		Do not rewrite	_	_	_
53h	3053h	[7:0]					
				Sync code setting			
				0h: Sync code Disable			
		0	SCDEN	1h: Sync code Enable	4		
		0	SCDEN	(In CSI-2, must set to 0h.)	1		immediately
				(In Low voltage LVDS serial, must set to			
				1h.)			
54h	3054h	1	_	Fixed to "1h"	1	67h	_
		2	_	Fixed to "1h"	1		_
		3	_	Fixed to "0h"	0		_
		4	_	Fixed to "0h"	0		_
		5	_	Fixed to "1h"	1		_
		6	_	Fixed to "1h"	1		_
		7	_	Fixed to "0h"	0		_

Add	Address		Dogistar nama	Description	Default value after reset		Reflection
4-wire	I ² C	bit	Register name	Description	By register	By address	timing
55h	3055h	[7:0]					
to	to	to	_	Do not rewrite	_	_	_
5Bh	305Bh	[7:0]					
5Ch	305Ch	[7:0]	INCKSEL1	The value is set according to INCK.	18h	18h	Immediately
5Dh	305Dh	[7:0]	INCKSEL2	The value is set according to INCK.	10h	10h	Immediately
5Eh	305Eh	[7:0]	INCKSEL3	The value is set according to INCK.	20h	20h	Immediately
5Fh	305Fh	[7:0]	INCKSEL4	The value is set according to INCK.	10h	10h	Immediately
60h	3060h	[7:0]					
to	to	to	_	Do not rewrite	_	_	_
FFh	30FFh	[7:0]					

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Registers corresponding to Chip ID = 03h in Write mode. (Read: Chip ID = 83h)

Ade	dress		Register name Description		Defaul after	t value reset	Reflection
4-wire	I ² C	bit	Register name	Description	By register	By address	timing
00h	3100h	[7:0]					
to	to	to	_	Do not rewrite	_	_	_
0Ah	310Ah	[7:0]					
0Bh	310Bh	[7:0]	_	Fixed to "07h" *	04h	04h	Immediately
0Ch	310Ch	[7:0]					
to	to	to	_	Do not rewrite	_	_	_
0Fh	310Fh	[7:0]					
10h	3110h	[7:0]		Fixed to "12h" *	0Eh	0Eh	Immediately
11h	3111h	[7:0]					
to	to	to	_	Do not rewrite	_	_	_
ECh	31ECh	[7:0]					
EDh	31EDh	[7:0]	_	Fixed to "38h" *	0Eh	0Eh	Immediately
EEh	31EEh	[7:0]					
to	to	to	_	Do not rewrite	_	_	_
FFh	31FFh	[7:0]					



Registers corresponding to Chip ID = 04h in Write mode. (Read: Chip ID = 84h)

Address		bit	Register name Description -	Description	Defaul after	Reflection	
4-wire	4-wire I ² C			By register	By address	timing	
00h	3200h	[7:0]					
to	to	to	_	Do not rewrite	_	_	_
FFh	32FFh	[7:0]					

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Registers corresponding to Chip ID = 05h in Write mode. (Read: Chip ID = 85h)
* Fixed values are set in LVDS and CSI-2 interface. Other registers are set in CSI-2 interface only.

Add	lress	bit	Register name	Description		t value reset	Reflection
4-wire	I ² C	DIL	Register Hame	Description	By register	By address	timing
00h	3300h	[7:0]					
to	to	to	_	Do not rewrite	_	_	_
37h	3337h	[7:0]					
38h	3338h	[7:0]	_	Fixed to "D4h" *	A0h	A0h	
39h	3339h	[7:0]	_	Fixed to "40h" *	C0h	C0h	_
3Ah	333Ah	[7:0]	<u> </u>	Fixed to "10h" *	12h	12h	
3Bh	333Bh	[7:0]	_	Fixed to "00h" * Fixed to "D4h" *	01h 00h	01h	
3Ch	333Ch	[7:0]	_	Fixed to "40h" *	00h	00h 00h	_
3Dh 3Eh	333Dh 333Eh	[7:0] [7:0]	_	Fixed to "10h" *	00h	00h	_
3Fh	333Fh	[7:0]		Fixed to "00h" *	01h	00h	
40h	3340h	[7:0]	_	i ixed to ooii	OIII	0111	
to	to	to	_	Do not rewrite	_	_	_
43h	3343h	[7:0]		Do not rownto			
		0	_	Fixed to "0h"	0h		_
		1	_	Fixed to "0h"	0h		_
		2		Fixed to "0h"	0h		_
		3	1	Fixed to "0h"	0h	001	_
44h	3344h	4 5	REPETITION [1:0]	Refer to each operating setting.	0h	00h	Immediately
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
45h	3345h	[7:0]	_	Do not rewrite	_	_	_
			PHYSICAL	Output interface selection			
				1: 2 Lane, 3: 4 Lane	3h		Immediately
		1	_LANE_NUM [1:0]	Others: Setting prohibited			
		2	<u> </u>	Fixed to "0h"	0h		_
46h	3346h	3		Fixed to "0h"	0h	03h	_
		4		Fixed to "0h"	0h		_
		5		Fixed to "0h"	0h		
		6		Fixed to "0h"	0h		
		7	_	Fixed to "0h"	0h		_
47h	3347h	[7:0]					
to	to	to	_	Do not rewrite	_	_	_
52h	3352h	[7:0]		l op			
		0		LSB			
		1		ODD Data Line number cetting			
		3	OB_SIZE_V [5:0]	OPB Data Line number setting * Refer to each operating setting.	0Eh		Immediately
53h	53h 3353h			Refer to each operating setting.		0Eh	
		<u>4</u> 5		MSB			
		6		Fixed to "0h"	0h		
		7	<u> </u>	Fixed to "0h"	0h		-
54h	3354h	[7:0]					
to	to	to	_	Do not rewrite			_
56h	3356h	[7:0]					
0311	000017	[0]					

Add	Iress					t value reset	Reflection
4-wire	I ² C	bit	Register name	Description	By register	By address	timing
		0		LSB	rogiotor	dadiooo	
		1					
		2					
		3				401	
57h	3357h	4				49h	
		5		Vartical (V) direction offective pixel width			
		6	PIC_SIZE_V [12:0]	Vertical (V) direction effective pixel width setting. * Refer to each operating setting.	0449h		Immediately
		7		Setting. Refer to each operating setting.			
		0					
		1					
		2					
58h	3358h	3				04h	
3011	333011	4		MSB		0-411	
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		
		7	_	Fixed to "0h"	0h		_
59h	3359h	[7:0]		_			
to	to	to	_	Reserved	_	_	_
6Ah	336Ah	[7:0]	T. 105.41T		0.51	0.51	
6Bh	336Bh	[7:0]	THSEXIT	Global timing setting	3Fh	3Fh	Immediately
6Ch	336Ch	[7:0]	TCLKPRE	Global timing setting	1Fh	1Fh	Immediately
6Dh	336Dh	[7:0]		D			
to	to	to	_	Reserved	_	_	_
7Ch	337Ch	[7:0]		LSB			
7Dh	337Dh	[7:0]	CSI_DT_FMT	LSB		0Ch	
			[15:0]	RAW10: 0A0Ah / RAW12: 0C0Ch	0C0Ch		Immediately
7Eh	337Eh	[7:0]	[13.0]	MSB		0Ch	
				Lane number setting			
		0	CSI_LANE_MODE	1:2 Lane, 3: 4 Lane	3h		Immediately
		1	[1:0]	Others: Setting prohibited			iiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiii
		2		Fixed to "0h"	0h		_
7Fh	337Fh	3	-00	Fixed to "0h"	0h	03h	_
		4		Fixed to "0h"	0h		_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
				LSB			
80h	3380h	[7.0]				40h	
0011	330011	[7:0]		Mostor clock frequency		4011	
			INCK_FREQ1	Master clock frequency 2520h: INCK = 37.125 MHz	4A40h		Immediately
			[15:0]	4A40h: INCK = 74.25 MHz	7/1-011		illillediately
81h	3381h	[7:01		THE WILL		4Ah	
	550111	[0]				17 11	
				MSB			
82h				Global timing setting	67h	67h	Immediately
83h	3383h			Global timing setting	1Fh	1Fh	Immediately
84h	3384h		THSZERO	Global timing setting	3Fh	3Fh	Immediately
85h	3385h		THSTRAIL	Global timing setting	27h	27h	Immediately
86h	3386h		TCLKTRAIL	Global timing setting	1Fh	1Fh	Immediately
87h	3387h		TCLKZERO	Global timing setting	17h	17h	Immediately
88h	3388h		TCLKZERO	Global timing setting	77h	77h	Immediately
89h	3389h	[/:0]	TLPX	Global timing setting	2Fh	2Fh	Immediately

Add	dress				Defaul after	Reflection	
4-wire	I ² C	bit	Register name	Description	By register	By address	timing
8Ah to 8Ch	338Ah to 338Ch	to	_	Reserved	_	_	_
8Dh	338Dh		INCK_FREQ2 [10:0]	LSB Master clock frequency 1B4h: INCK = 37.125 MHz 367h: INCK = 74.25 MHz	367h	67h	Immediately
8Eh	338Eh	[2:0]		MSB		03h	
OLII	JOOLII	[7:3]	_	Fixed to "00h"	00h	0011	_
8Fh to FFh	338Fh to 33FFh	to	_	Reserved	_	_	_

Pomertex Chomb

Readout Drive mode

The table below lists the operating modes available with this sensor. (N/A: Not supported mode)

			۸۵		F	Data rate				
Window	Mode	de [MHz]	AD conversion	bit Frame width	Serial LVDS [Mbps/ch]			CSI-2 [Mbps/Lane]		
			[bit]	[bit]	[frame/s]	2 ch	4 ch	8 ch	2 Lane	4 Lane
			10	10	10 12 30 / 25 10 60 / 50	371.25	185.625	92.8125	371.25	185.625
All-pixel	All pixel		12	12		445.5	222.75	111.375	445.5	222.75
scan		37.125 74.25	10	10		N/A	371.25	185.625	742.5	371.25
1080p-HD		61 74.23	12	12	60750	N/A	445.5	222.75	N/A	445.5
			10	10	120 / 100	N/A	N/A	371.25	N/A	742.5

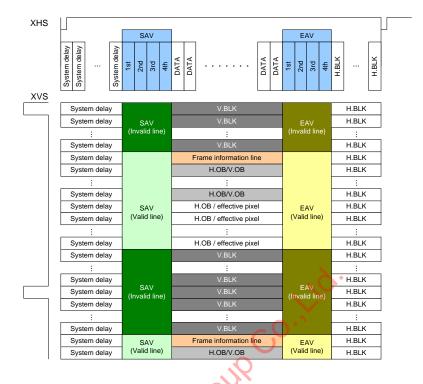


			F	Recording pixels		Total n	xels		
Window	Mode	INCK	Frame rate			Н [р	ixels]		1H period
VVIIIGOW	Wode	[MHz]	[frame/s]	Н	V	LVDS	LVDS	V	[µs]
			[ITATTIC/S]	[pixels]	[lines]	CSI-2	CSI-2	[lines]	
						(10 bit)	(12 bit)		
			25			2640	2640		35.6
			30			2200	2200		29.6
All-pixel scan	All pivol	37.125	50	1920	1080	2640	2640	1125	17.8
1080p-HD	All-pixel	74.25	60	1920	1060	2200	2200	1125	14.8
			100			2640	N/A		8.9
			120			2200	N/A		7.4

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Sync code (Serial LVDS output)

The sync code is added immediately before and after "dummy signal + OB signal + effective pixel data" and then output. The sync code is output in order of 1st, 2nd, 3rd and 4th. The fixed value is output for 1st to 3rd. (BLK: Blanking period)



Sync Code Output Timing

List of Sync Code

Cuna aada	1st c	code 🧎	2nd code		3rd code		4th code	
Sync code	10 bit	12 bit	10 bit	12 bit	10 bit	12 bit	10 bit	12 bit
SAV (Valid line)	3FFh	FFFh	000h	000h	000h	000h	200h	800h
EAV (Valid line)	3FFh	FFFh	000h	000h	000h	000h	274h	9D0h
SAV (Invalid line)	3FFh	FFFh	000h	000h	000h	000h	2ACh	AB0h
EAV (Invalid line)	3FFh	FFFh	000h	000h	000h	000h	2D8h	B60h

(Note) They are output to each channel seriously in MSB first when low-voltage LVDS serial. For details, see the item of "Signal output" and "Output pin setting".

Sync Code Output Timing

The sensor output signal passes through the internal circuits and is output with a latency time (system delay) relative to the horizontal sync signal. This system delay value is undefined for each line, so refer to the sync codes output from the sensor and perform synchronization.



Image Data Output Format (CSI-2 output)

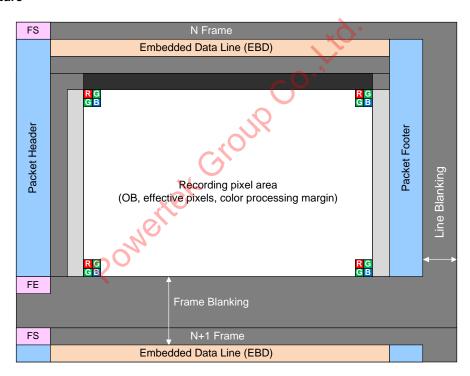
Frame Format

Each line of each image frame is output like the General Frame Format of CSI-2. The settings for each packet header are shown below.

DATA Type

Header [5:0]	Name	Setting register (I ² C)	Description		
00h	Frame Start Code	N/A	FS		
01h	Frame End Code	N/A	FE		
10h	NULL	N/A	Invalid data		
12h	Embedded Data	N/A	Embedded data		
2Bh	RAW10	Address: 7Dh, 7Eh (337Dh, 337Eh)	0A0Ah		
2Ch	RAW12	CSI_DT_FMT [15:0]	0C0Ch		
37h	OB Data	N/A	Vertical OB line data		

Frame Structure

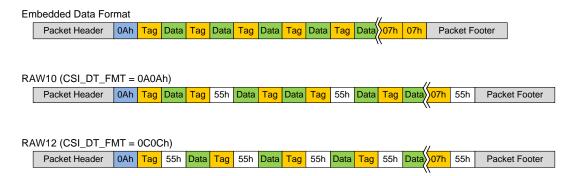


Frame Structure of CSI-2 output

SONY

Embedded Data Line

The Embedded data line is output in a line following the sync code FS.



The end of the address and the register value is determined according to the tags embedded in the data.

Embedded Data Line Tag

Tag	Data Byte Description
00h	Illegal Tag. If found; treat as end of Data.
07h	End of Data.
AAh	CCI Register Index MSB [15:8]
A5h	CCI Register Index LSB [7:0]
5Ah	Auto increment the CCI index after the data byte – valid data Data byte contains valid CCI register data.
55h	Auto increment the CCI index after the data byte – null data A CCI register does not exist for the current CCI index. The data byte value is the 07h.
FFh	Illegal Tag. If found; treat as end of Data.

SONY

Specific output examples are shown below. (4-wire: Chip ID = 05h)

Pixel 4-w 1	hh hh hh hh hh hh	3395h 3396h 3397h 3398h 3399h	Data Byte Description Data Format CCI Register Index MSB [15:8] CCI Register Index LSB [7:0] REGHOLD value Fixed to "00h" Fixed to "85h" Fixed to "03h"	Value OAh AAh 33h A5h 95h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h
1	hh hh hh hh hh hh	3395h 3396h 3397h 3398h 3399h	CCI Register Index MSB [15:8] CCI Register Index LSB [7:0] REGHOLD value Fixed to "00h" Fixed to "00h" Fixed to "85h"	AAh 33h A5h 95h 5Ah 00h 5Ah [0]* 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h
2 3 4 5 6 7 95 8 9 96 10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9C 24 25 9E 26 27 9F 28 29 AC 30 31 AC 31 32 33 AC 33 AC 33 AC 34 35 AC 36 AC 36 AC 37 38 38 38 38 38 38 38 38 38 38	hhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhh	3396h 3397h 3398h 3399h	CCI Register Index MSB [15:8] CCI Register Index LSB [7:0] REGHOLD value Fixed to "00h" Fixed to "00h" Fixed to "85h"	AAh 33h A5h 95h 5Ah 00h 5Ah [0]* 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h
3 4 5 6 7 95 8 9 96 10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	hhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhh	3396h 3397h 3398h 3399h	CCI Register Index LSB [7:0] REGHOLD value Fixed to "00h" Fixed to "00h" Fixed to "85h"	33h A5h 95h 5Ah 00h 5Ah [0]* 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h
4 5 6 7 95 8 9 96 10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	hhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhh	3396h 3397h 3398h 3399h	CCI Register Index LSB [7:0] REGHOLD value Fixed to "00h" Fixed to "00h" Fixed to "85h"	A5h 95h 5Ah 00h 5Ah [0]* 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h
5 6 7 95 8 9 96 10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	hhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhh	3396h 3397h 3398h 3399h	CCI Register Index LSB [7:0] REGHOLD value Fixed to "00h" Fixed to "00h" Fixed to "85h"	95h 5Ah 00h 5Ah [0]* 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 85h 03h
6 7 95 8 9 96 10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	hhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhh	3396h 3397h 3398h 3399h	REGHOLD value Fixed to "00h" Fixed to "00h" Fixed to "85h"	5Ah 00h 5Ah [0]* 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h
6 7 95 8 9 96 10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	hhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhh	3396h 3397h 3398h 3399h	REGHOLD value Fixed to "00h" Fixed to "00h" Fixed to "85h"	5Ah 00h 5Ah [0]* 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h 5Ah 00h
7 95 8 9 96 10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	hhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhh	3396h 3397h 3398h 3399h	Fixed to "00h" Fixed to "00h" Fixed to "85h"	5Ah [0]* 5Ah 00h 5Ah 00h 5Ah 5Ah 85h 5Ah 03h
8 9 96 10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	hhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhhh	3396h 3397h 3398h 3399h	Fixed to "00h" Fixed to "00h" Fixed to "85h"	5Ah [0]* 5Ah 00h 5Ah 00h 5Ah 5Ah 85h 5Ah 03h
9 96 10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	h h	3397h 3398h 3399h 339Ah	Fixed to "00h" Fixed to "00h" Fixed to "85h"	[0]* 5Ah 00h 5Ah 00h 5Ah 85h 85h 5Ah
10 11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	h h	3397h 3398h 3399h 339Ah	Fixed to "00h" Fixed to "85h"	5Ah 00h 5Ah 00h 5Ah 85h 5Ah 03h
11 97 12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 A3 35 A3	h h	3398h 3399h 339Ah	Fixed to "00h" Fixed to "85h"	00h 5Ah 00h 5Ah 85h 5Ah 03h
12 13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	h h	3398h 3399h 339Ah	Fixed to "00h" Fixed to "85h"	5Ah 00h 5Ah 85h 5Ah 03h
13 98 14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	h .h	3399h 339Ah	Fixed to "85h"	00h 5Ah 85h 5Ah 03h
14 15 99 16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	h .h	3399h 339Ah	Fixed to "85h"	5Ah 85h 5Ah 03h
15 99 16 17 9A 18 19 9E 20 21 9C 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	sh :	339Ah		85h 5Ah 03h
16 17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	sh :	339Ah		5Ah 03h
17 9A 18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	sh :		Fixed to "03h"	03h
18 19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3	sh :		rixed to USII	
19 9E 20 21 9C 22 23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3		339Bh		
20 21 90 22 23 90 24 25 96 27 96 28 29 A0 30 31 A1 32 33 A2 34 35 A3		339BN	Fig. 1. 1 = "OAL"	5Ah
21 90 22 23 9E 24 25 9E 26 27 9F 28 29 A0 30 31 A1 32 33 A2 34 A3	h :		Fixed to "01h"	01h
22 23 9D 24 25 9E 26 27 9F 28 29 AO 30 31 A1 32 33 A2 34 35 A3	h			5Ah
23 9E 24 25 9E 26 27 9F 28 29 AC 30 31 A1 32 33 A2 34 35 A3		339Ch	Fixed to "01h"	01h
24 25 9E 26 27 9F 28 29 A0 30 31 A1 32 33 A2 34 35 A3	. 1		Frame count	5Ah
25 9E 26 27 9F 28 29 A0 30 31 A1 32 33 A2 34 35 A3)h	339Dh		[7:0]*
26 27 9F 28 29 A0 30 31 A1 32 33 A2 34 35 A3				5Ah
27 9F 28 29 A0 30 31 A1 32 33 A2 34 35 A3	h	339Eh	Fixed to "01h"	01h
28 29 A0 30 31 A1 32 33 A2 34 35 A3				5Ah
29 A0 30 31 A1 32 33 A2 34 35 A3	h	339Fh	Black level setting value	[7:0]*
30 31 A1 32 33 A2 34 35 A3				5Ah
31 A1 32 33 A2 34 35 A3	h :	33A0h		[15:8]*
32 33 A2 34 35 A3			Data format	5Ah
33 A2 34 35 A3	h :	33A1h	Data format RAW10: 0A0Ah	[7:0]*
34 35 A3			RAW12: 0C0Ch	5Ah
35 A3	h :	33A2h	10.0012.0000	[15:8]*
—			·	5Ah
36	h :	33A3h	Fixed to "00h"	00h
00				5Ah
37 A4	h	33A4h	Fixed to "00h"	00h
38				5Ah
39 A5	h :	33A5h	Fixed to "00h"	00h
40				5Ah
41 A6	ih :	33A6h	Fixed to "F0h"	F0h
42	T			5Ah
43 A7	'n.	33A7h	Fixed to "00h"	00h
44				5Ah
45 A8	sh :	33A8h	Fixed to "01h"	01h
46				5Ah
47 A9	h	33A9h	Fixed to "00h"	00h
48	1			5Ah
49 AA	h :	33AAh	Fixed to "00h"	00h
50				5Ah
51 AE		33ABh	Fixed to "00h"	00h
52	3h			5Ah
53 AC	3h	33ACh	Fixed to "00h"	00h
51 AE				00h

Pixel			Data Byte Description	Value
	4-wire	I ² C	, , , , , , , , , , , , , , , , , , ,	
54				5Ah
55	ADh	33ADh	Fixed to "F0h"	F0h
56				5Ah
57	AEh	33AEh	Fixed to "00h"	00h
58				5Ah
59	AFh	33AFh	Fixed to "01h"	01h
60				5Ah
61	B0h	33B0h	Fixed to "00h"	00h
62				5Ah
63	B1h	33B1h	Fixed to "F0h"	F0h
64				5Ah
65	B2h	33B2h	Fixed to "00h"	00h
66				5Ah
67	B3h	33B3h	Gain Setting Value	[7:0]*
68			g .	5Ah
69	B4h	33B4h		[15:8]*
70				5Ah
71	B5h	33B5h	Shutter setting value	[7:0]*
72			3	5Ah
73	B6h	33B6h		[15:8]*
74	- 0			5Ah
75	B7h	33B7h	Fixed to "00h"	00h
76				5Ah
77	B8h	33B8h	Fixed to "00h"	00h
78				5Ah
79	B9h	33B9h	Fixed to "00h"	00h
80				5Ah
81	BAh	33BAh	Fixed to "00h"	00h
82				5Ah
83	BBh	33BBh	Fixed to "00h"	00h
84				5Ah
85	BCh	33BCh	Fixed to "00h"	00h
86				5Ah
87	BDh	33BDh	Fixed to "00h"	00h
88	 :	005=:	F: 1, "001"	5Ah
89	BEh	33BEh	Fixed to "00h"	00h
90	DE:	005=	F: 1, "001"	5Ah
91	BFh	33BFh	Fixed to "00h"	00h
92	00'	2222	Fixed to "OOK"	5Ah
93	C0h	33C0h	Fixed to "00h"	00h
94	041	2224	Fixed to "OOK"	5Ah
95	C1h	33C1h	Fixed to "00h"	00h
96	001	22021	Fixed to "OOL"	5Ah
97	C2h	33C2h	Fixed to "00h"	00h
98	Cal	22021	Fixed to "OOb"	5Ah
99	C3h	33U3N	Fixed to "00h"	00h
100	CAL	22016	Fixed to "OOh"	5Ah
101	C4h	33C4N	Fixed to "00h"	00h
102	CEL	22056	Fixed to "OOk"	5Ah
103	C5h	33C5I)	Fixed to "00h"	00h
104	Cer	330ch	Fixed to "OOh"	5Ah
105	C6h	33CbN	Fixed to "00h"	00h
106	C7h	22074	Fixed to "OOh"	5Ah
107	C7h	SSC/N	Fixed to "00h"	00h

	Add	ress		
Pixel	[HE	ΞX]	Data Byte Description	Value
	4-wire	I ² C	,	
108				5Ah
109	C8h	33C8h	Fixed to "00h"	00h
110				5Ah
111	C9h	33C9h	Vertical line value	[7:0]*
112			(VMAX)	5Ah
113	CAh	33CAh		[15:8]*
114				5Ah
115	CBh	33CBh	Fixed to "00h"	00h
116	ODII	OOODII	1 1/100 10 0011	5Ah
117	CCh	33CCh	Horizontal clock value	[7:0]*
118	0011	000011	(HMAX)	5Ah
119	CDh	33CDh	(i iwizazi)	[15:8]*
20	CDII	JJCDII		5Ah
121	CEh	22CEh	Fixed to "00h"	00h
122	CEII	SSCEII	Fixed to OOII	5Ah
	CEL	22056	Fixed to "OOh"	
123	CFh	33CFn	Fixed to "00h"	00h
124	Dol	00001	F: 14 "001"	5Ah
125	D0h	33D0h	Fixed to "00h"	00h
126				5Ah
127	D1h	33D1h	Fixed to "00h"	00h
128				5Ah
129	D2h	33D2h	Fixed to "9Bh"	9Bh
130				5Ah
131	D3h	33D3h	Fixed to "07h"	07h
132				5Ah
133	D4h	33D4h	Fixed to "C8h"	C8h
134				5Ah
135	D5h	33D5h	Fixed to "04h"	04h
136				5Ah
137	D6h	33D6h	Fixed to "9Ch"	9Ch
138				5Ah
139	D7h	33D7h	Fixed to "07h"	07h
140				5Ah
141	D8h	33D8h	Fixed to "C9h"	C9h
142				5Ah
143	D9h	33D9h	Fixed to "04h"	04h
144				5Ah
145	DAh	33DAh	Fixed to "00h"	00h
146				5Ah
147	DBh	33DBh	Fixed to "00h"	00h
148				5Ah
149	DCh	33DCh	Fixed to "00h"	00h
150				5Ah
151	DDh	33DDh	Fixed to "00h"	00h
152				5Ah
153	DEh	33DFh	Fixed to "00h"	00h
154	2=11	JUDEN		5Ah
155	DFh	33DFh	Fixed to "00h"	00h
156	וווט	SODEII	I IAOU TO TOTT	5Ah
157	E0h	ЗЗEUP	Fixed to "1Bh"	1Bh
-	LUII	JUEUN	וואפט נט וטוו	
158	E1h	22546	Fixed to "OFh"	5Ah
159	E1h	SSE III	Fixed to "05h"	05h
160	E0F	22501	Fixed to "DOb"	5Ah
161	E2h	JJEZN	Fixed to "D0h"	D0h

Pixel	Add [HE	ress =X1	Data Byte Description	Value
1 IXCI	4-wire	I ² C	Butta Byto Bosonphon	value
162				5Ah
163	E3h	33E3h	Fixed to "03h"	03h
164				5Ah
165	E4h	33E4h	Fixed to "7Ch"	7Ch
166				5Ah
167	E5h	33E5h	Fixed to "01h"	01h
168				5Ah
169	E6h	33E6h	Fixed to "31h"	31h
170	C71-	22574	Fixed to "O4b"	5Ah
171	E7h	33E/N	Fixed to "01h"	01h
172	Foh	22506	Fixed to "4Ch"	5Ah
173	E8h	335011	Fixed to "1Ch"	1Ch
174 175	E9h	22E0h	Fixed to "05h"	5Ah 05h
176	Lan	33L911	Tixed to 03H	5Ah
177	EAh	33 ⊑ ∆h	Fixed to "D1h"	D1h
178	LAII	JJLAII	I IXEG TO DITT	5Ah
179	EBh	33FRh	Fixed to "03h"	03h
180	LDII	OOLDII	TING TO COLL	5Ah
181	ECh .	33ECh	Fixed to "01h"	01h
182	LOII	002011	TIXES TO THE	5Ah
183	EDh •	33EDh	Number of lane	[1:0]*
184	- 400	OOLDII		5Ah
185	EEh	33FFh	Fixed to "00h"	00h
186		5522	i mad to con	5Ah
187	EFh	33EFh	Fixed to "00h"	00h
188				5Ah
189	F0h	33F0h	Fixed to "0Bh"	0Bh
190				5Ah
191	F1h	33F1h	Fixed to "00h"	00h
192				5Ah
193	F2h	33F2h	Fixed to "0Ch"	0Ch
194				5Ah
195	F3h	33F3h	Fixed to "00h"	00h
196				5Ah
197	F4h	33F4h	Fixed to "00h"	00h
198				5Ah
199	F5h	33F5h	Fixed to "00h"	00h
200				5Ah
201	F6h	33F6h	Fixed to "0Fh"	0Fh
202				5Ah
203	F7h	33F7h	Fixed to "00h"	00h
204				5Ah
205	F8h	33F8h	Fixed to "06h"	06h
206				5Ah
207	F9h	33F9h	Fixed to "00h"	00h
208	 ,	00=::	E: 1, "401"	5Ah
209	FAh	33FAh	Fixed to "10h"	10h
210	F5:	0055	Fire I to "OOL"	5Ah
211	FBh	33⊦Bh	Fixed to "00h"	00h
212			End of Date	07h
213	_	_	End of Data.	07h
214		4 alaa	in Data Byte Description is output.	07h

^{*} The value that shown in Data Byte Description is output.

Image Data Output Format

All-pixel scan mode (1080p-HD)

List of Setting Register for LVDS serial output

Add	ress			Initial	ial LVDS serial			
4-wire	I ² C	bit	Register Name	Value	2 ch	4 ch	8 ch	Remarks
Chip ID:	: 02h							
05h	3005h	[0]	ADBIT	0h		0h / 1h		0: 10 bit, 1: 12 bit
		[0]	VREVERSE	0h		0h / 1h		0: Normal, 1: Inverted
07h	3007h	[1]	HREVERSE	0h		0h / 1h		0: Normal, 1: Inverted
		[7:4]	WINMODE	0h		0h		All-pixel scan
						2h		30 / 25 [frame/s]
09h	3009h	[1:0]	FRSEL	1h	N/A	1	h	60 / 50 [frame/s]
0911	300911				N/A	N/A	0h	120 / 100 [frame/s]
		[4]	FDG_SEL	0h		0h / 1h		0: LCG mode, 1: HCG mode
18h	3018h	[7:0]						
10h	2010h	[7.0]	\/NAA \	46Eh		4CEh		
19h	3019h	[7.0]	VIVIAA	465h		465h		_
1Ah	301Ah	[0]						
						14A0h		25 [frame/s]
1Bh	301Bh	[7:0]				1130h	λ.	30 [frame/s]
					N1/A		XO	
			HMAX	0898h	N/A	A5	0h	50 [frame/s]
405	00401	[5.0]			N/A	89	8h	60 [frame/s]
1Ch	301Ch	[5:0]			N/A	N/A	528h	100 [frame/s]
					N/A	N/A	44Ch	120 [frame/s]
4.4h	3044h	[1:0]	ODBIT	1h		0h / 1h		0: 10 bit, 1: 12 bit
44h	304411	[7:4]	OPORTSEL	0h	Dh	Eh	Fh	I/F selection
54h	3054h	[0]	SCDEN	1h		1h		LVDS setting
5Ch	305Ch	[7:0]	INCKSEL1	18h	O	28h / 18h		Set according to INCK setting
5Dh	305Dh	[7:0]	INCKSEL2	10h		10h / 00h		Set according to INCK setting
5Eh	305Eh	[7:0]	INCKSEL3	20h		20h		Set according to INCK setting
5Fh	305Fh	[7:0]	INCKSEL4	10h		10h / 00h		Set according to INCK setting
60h	3060h	[7:0]	Ne					
to	to		Set register value	that des	scribed on iter	m "Register m	ıap".	
FFh	30FFh	[7:0]	0					
Chip ID		r= 01						
00h	3100h	[7:0]	Cat na miatan walioa	414-1		"D:-t	"	
to FFh	to 31FFh		Set register value	that des	scribed on iter	m Register m	ар.	
Chip ID		[7.0]						
00h		[7:0]						
to	to	to	Set register value	that des	scribed on iter	m "Register m	an".	
FFh			Cot logicioi value			rtogiotoi III	.∽ r .	
Chip ID		[]						
00h	3300h	[7:0]						-
to	to	to	Changing the valu	e is not	necessary.			
FFh	33FFh	[7:0]	- -					

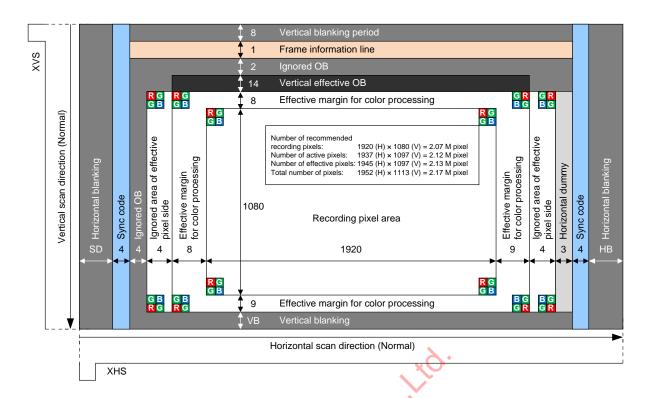
List of Setting Register for CSI-2 serial output

A -1 -1											
Add	ress	bit	Register Name	Initial		2/4	lane		4 1	ane	Remarks
4-wire	I ² C	Dit	Register Name	Value	25	30	50	60	100	120	Remarks
4-wire	10				[frame /s]	[frame /s]	[frame /s]	[frame /s]	[frame /s]	[frame /s]	
Chip ID:	02h										
05h	3005h	[0]	ADBIT	0h			0h	/ 1h			0: 10 bit, 1: 12 bit
		[0]	VREVERSE	0h			0h	/ 1h			0: Normal, 1: Inverted
07h	3007h	[1]	HREVERSE	0h	0h / 1h					0: Normal, 1: Inverted	
		[7:4]	WINMODE	0h			C)h			All-pixel scan
		[1:0]	FRSEL	1h	2	h	1	h	C)h	
09h	3009h	[4]	FDG_SEL	0h			0h	/ 1h			0: LCG mode,
4.01-	204.01-	[7.0]									1: HCG mode
18h	3018h	[7:0]	VAAAV	40Eh							
19h	3019h		VMAX	465h	465h						
1Ah 1Bh	301Ah 301Bh	[0] [7:0]									
1Ch	301Ch	[5:0]	HMAX	0898h	14A0h	1130h	A50h	898h	528h	44Ch	H direction designated
1011	301011	[1:0]	ODBIT	1h				In CSI-2, fixed to "1h".			
44h	3044h		OPORTSEL	0h				In CSI-2, fixed to "0h".			
54h	3054h		SCDEN	1h)h)h			CSI-2 setting
5Ch	305Ch	• •	INCKSEL1	18h				/ 18h	7.		Set according to INCK
5Dh	305Dh		INCKSEL2	10h				/ 00h	,		Set according to INCK
5Eh	305Eh		INCKSEL3	20h				0h			Set according to INCK
5Fh	305Fh		INCKSEL4	10h			10h	/00h			Set according to INCK
60h	3060h	[7:0]		L. L.)			, ,
to	to	to	Set register value	that desc	cribed on iter	m "Register n	nap".				
FFh	30FFh	[7:0]									
Chip ID =	= 03h					- 3(
00h	3100h	[7:0]									
to	to	to	Set register value	that desc	cribed on iter	n "Register n	nap".				
FFh	31FFh	[7:0]									
Chip ID =	= 04h				X						
00h	3200h	[7:0]			.0)						
to	to	to	Set register value	that desc	cribed on iter	m "Register n	nap".				
FFh	32FFh	[7:0]		\sim 0	*						

IMX385LQR-C

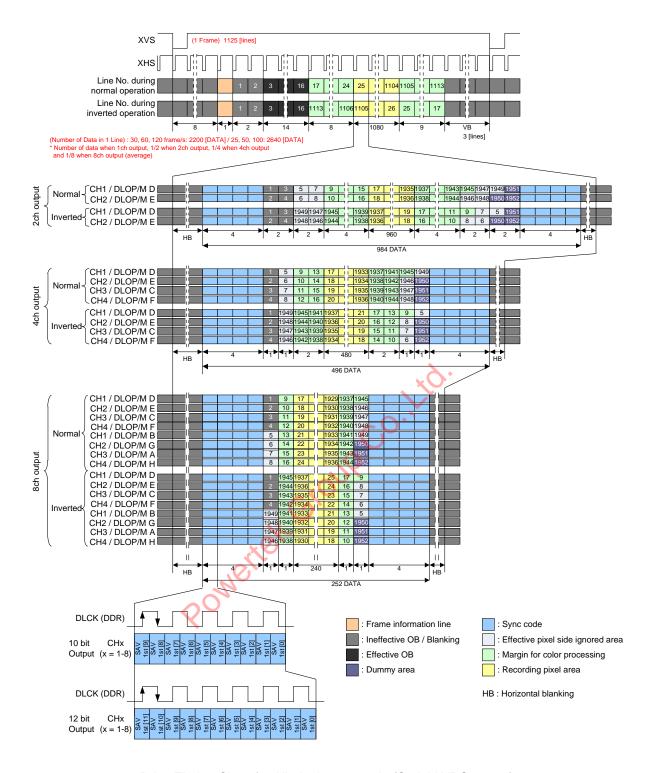
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							CSI-2 serial			Remarks	
							10 bit	12 bit	10 bit		
Add	ress			1 20 1	N/A	N/A	25 / 30	25 / 30	50 / 60	2 lane	
		bit	Register Name	Initial			[frame/s]	[frame/s]	[frame/s]		
				Value	10 bit	12 bit	10 bit	12 bit	10 bit		
4-wire	I ² C				25 / 30	25 / 30	50 / 60	50 / 60	100 / 120	4 lane	
					[frame /s]	[frame /s]	[frame /s]	[frame /s]	[frame /s]		
Chip ID =	= 05h										
		Da	ta rate		185.625	222.75	371.25	445.5	742.5	[Mbps / Lane]	
44h	3344h	[5:4]	REPETITION	0h	2h	1h	1h	0h	0h	_	
40h	20.465	[4.0]	PHYSICAL_	O.b.				1h : 2 lane			
46h	3346h	[1:0]	LANE_NUM	3h				3h : 4 lane			
53h	3353h	[5:0]	OB_SIZE_V	Eh			_				
57h	3357h	[7:0]	DIC CIZE V	449h							
58h	3358h	[4:0]	PIC_SIZE_V	449N			449h			_	
6Bh	336Bh	[7:0]	THSEXIT	3Fh	27h	2Fh	37h	3Fh	5Fh	Global timing	
6Ch	336Ch	[7:0]	TCLKPRE	1Fh			1Fh			Global timing	
7Dh	337Dh	[7:0]	OOL DT. FMT.	00001			0A0Ah: RAW10				
7Eh	337Eh	[7:0]	CSI_DT_FMT	0C0Ch			0C0Ch: RAW12				
754	007Fb	[4.0]	CSI_LANE_	O.F.			1h : 2 lane				
7Fh	337Fh	[1:0]	MODE	3h			1h / 3h			3h : 4 lane	
80h	3380h	[7:0]	INCK FREQ1	4A40h			6 MHz: 2520h	×9.		Set according to INCK	
81h	3381h	[7:0]				74.25	6 MHz: 4A40h			oct associating to intent	
82h	3382h	[7:0]	TCLKPOST	67h	57h	5Fh	5Fh	67h	77h	Global timing	
83h	3383h	[7:0]	THSPREPARE	1Fh	0Fh	17h	1Fh	1Fh	2Fh	Global timing	
84h	3384h	[7:0]	THSZERO	3Fh	2Fh	2Fh	37h	3Fh	5Fh	Global timing	
85h	3385h	[7:0]	THSTRAIL	27h	17h	17h	1Fh	27h	37h	Global timing	
86h	3386h	[7:0]	TCLKTRAIL	1Fh	0Fh	17h	1Fh	1Fh	37h	Global timing	
87h	3387h	[7:0]	TCLKPREPARE	17h	0Fh	0Fh	17h	17h	37h	Global timing	
88h	3388h	[7:0]	TCLKZERO	77h	37h	4Fh	67h	77h	BFh	Global timing	
89h	3389h	[7:0]	TLPX	27h	1Fh	27h	27h	27h	3Fh	Global timing	
8Dh	338Dh	[7:0]	INCK FREQ2	0367h	Jerr		5 MHz: 01B4h			Set according to INCK	
8Eh	338Eh	74.25 MHz: 0367h									

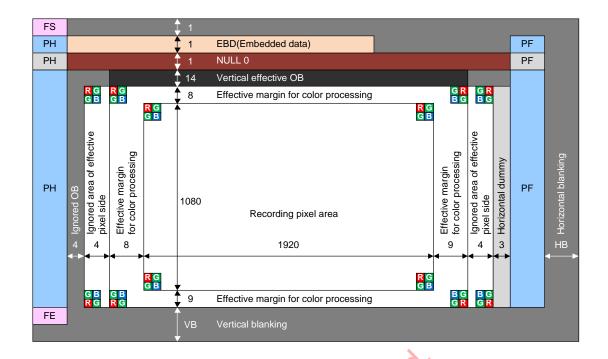


Pixel Array Image Drawing in All-pixel scan mode (Serial LVDS output)

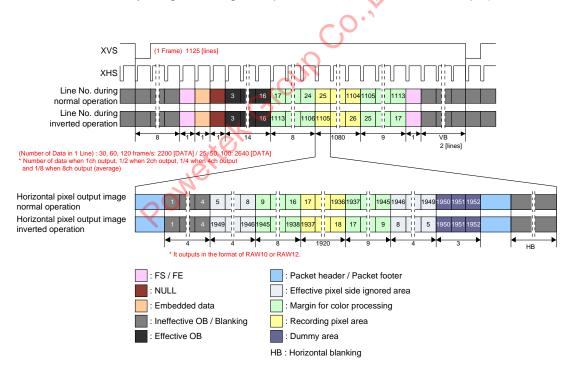
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Drive Timing Chart for All-pixel scan mode (Serial LVDS output)



Pixel Array Image Drawing in All-pixel scan mode (CSI-2 serial output)



Drive Timing Chart for All-pixel scan mode (CSI-2 serial output)

Window Cropping Mode

Sensor signals are cut out and read out in arbitrary positions.

Cropping position is set, regarding effective pixel start position as origin (0, 0) in all pixel scan mode. Cropping is available from all-pixel scan mode and vertical, horizontal period and frame rate are fixed to the value for this mode. Pixels cropped by horizontal cropping setting are output with left justified and that extends the horizontal blanking period.

Window cropping image is shown in the figure below.

Cropping position is set, regarding effective pixel start position as origin (0, 0) in all pixel scan mode.

Only vertical width can be set for OB (horizontal width is the same as the Window cropping width).

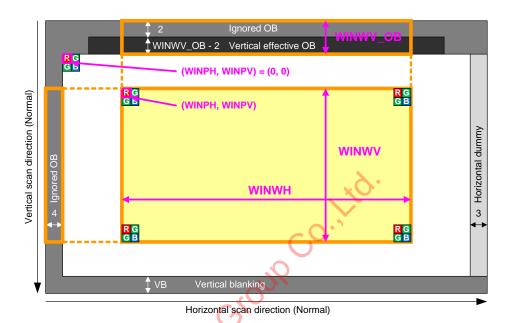


Image Drawing of Window Cropping Mode

Restrictions on Window cropping mode

The register settings should satisfy following conditions:

WINPH + WINWH ≤ 1944 368 ≤ WINWH
Set WINPH and WINWH to a multiple of 4.

 V_{TTL} (Number of lines per frame or VMAX) \geq WINWV_OB + WINWV + 13

However, $6 \le WINWV_OB \le 16$ WINPV + WINWV ≤ 1096 $304 \le WINWV$ OB_SIZE_V = WINWV_OB - 2 (In CSI-2 output) PIC_SIZE_V = WINWV (In CSI-2 output)

Frame rate on Window cropping mode Frame rate [frame/s] = $1 / (V_{TTL} \times (1H \text{ period}))$

1H period (unit: [µs]): Fix 1H time in a mode before cropping and calculate it by the value of "Number of INCK in 1H" in the table of "Operating Mode" and "List of Operation Modes and Output Rates".

List of Setting Register for LVDS serial output

Add	Iress			Initial		LVDS serial				
4-wire	I ² C	bit	Register Name	Value	2 ch	4 ch	8 ch	Remarks		
Chip ID:	: 02h									
05h	3005h	[0]	ADBIT	0h		0h / 1h		0: 10 bit, 1: 12 bit		
		[0]	VREVERSE	0h		0h / 1h		0: Normal, 1: Inverted		
07h	3007h	[1]	HREVERSE	0h		0h / 1h		0: Normal, 1: Inverted		
		[7:4]	WINMODE	0h		4h		Window cropping		
						2h		_		
09h	3009h	[1:0]	FRSEL	1h	N/A	1	h	_		
U9fi	300911				N/A	N/A	0h	_		
		[4]	FDG_SEL	0h		0h / 1h		0: LCG mode, 1: HCG mode		
18h	3018h	[7:0]								
19h	3019h	[7:0]	VMAX	465h		V_{TTL}		See previous page.		
1Ah	301Ah	[0]								
						14A0h		*1: 10 bit / 12 bit available		
1Bh	301Bh [7:0		301Bh	[7:0]				1130h		*2: 10 bit / 12 bit available
					N/A	A50h		*3: 10 bit / 12 bit available		
			HMAX	0898h	19/73	Ao	011	3. TO Sit / 12 Sit available		
1Ch	301Ch	[5:0]			N/A	89	8h	*4: 10 bit / 12 bit available		
1011		[0.0]			N/A	N/A	528h	*5: 10 bit only		
					N/A	N/A	44Ch	*6: 10 bit only		
44h	3044h		ODBIT	1h		0h / 1h		0: 10 bit, 1: 12 bit		
			OPORTSEL	0h	Dh	Eh	Fh	I/F selection		
54h	3054h		SCDEN	1h		1h	<u> </u>	LVDS setting		
5Ch			INCKSEL1	18h		28h / 18h		Set according to INCK		
5Dh	305Dh		INCKSEL2	10h		10h / 00h		Set according to INCK		
5Eh	305Eh		INCKSEL3	20h		20h		Set according to INCK		
5Fh	305Fh		INCKSEL4	10h		10h / 00h		Set according to INCK		
60h	3060h				O					
to	to	to	Set register value	that des	cribed on iter	n "Register m	ap".			
FFh	30FFh	[7:0]		×	<u>C'</u>					
Chip ID	3100h	[7:01								
00h to	to		Set register value	that don	cribed on iter	n "Pagistor m	an"			
FFh	31FFh		Set register value	mai des	cribed on iter	ii Kegistei iii	ар.			
Chip ID		[/.0]								
00h	3200h	[7:01								
to	to	to	Set register value	that des	cribed on iter	n "Register m	ap".			
FFh	32FFh		Cot regioter value	at acc	onbod on ito	regiotoi ili	ωp .			
Chip ID]								
00h	3300h	[7:0]								
to	to	to	Changing the valu	e is not	necessary.					
FFh	33FFh	[7:0]			•					



List of Setting Register for CSI-2 serial output

Address				Initial											
Addi	Address		Register Name	Value		2/4	lane		4 la	ane	Remarks				
4-wire	I ² C			value	*1	*1 *2 *3 *4 *5 *6									
Chip ID: 02h															
05h	3005h	[0]	ADBIT	0h			0: 10 bit, 1: 12 bit								
		[0]	VREVERSE	0h			0h /	′ 1h			0: Normal, 1: Inverted				
07h	3007h	[1]	HREVERSE	0h			0h /	′ 1h			0: Normal, 1: Inverted				
		[7:4]	WINMODE	0h			4	h			Window cropping				
		[1:0]	FRSEL	1h	2	h	1	h	0	h	_				
09h	3009h	[4]	FDG_SEL	0h			0h /	′ 1h			0: LCG mode, 1: HCG mode				
18h	3018h	[7:0]													
19h	3019h	[7:0]	VMAX	465h			V ₁	TL			See previous page				
1Ah	301Ah	[0]													
1Bh	301Bh	[7:0]		HMAX	LINAAV	LIMAV	LIMAV	0898h	14A0h	1130h	A50h	909h	528h	44Ch	H direction designated
1Ch	301Ch	[5:0]	HIVIAA	009011	14AUII	14A0h 1130h A50h 898h 528h 44Ch				i i direction designated					
44h	3044h	[1:0]	ODBIT	1h	1h						In CSI-2, fixed to "1h".				
4411	304411	[7:4]	OPORTSEL	0h			In CSI-2, fixed to "0h".								
54h	3054h	[0]	SCDEN	1h			0	h			CSI-2 setting				
5Ch	305Ch	[7:0]	INCKSEL1	2Ch			28h /	/ 18h			Set according to INCK				
5Dh	305Dh	[7:0]	INCKSEL2	10h			10h	/ 00h	<u>O.</u>		Set according to INCK				
5Eh	305Eh	[7:0]	INCKSEL3	2Ch			20)h			Set according to INCK				
5Fh	305Fh	[7:0]	INCKSEL4	10h			10h	/ 00h			Set according to INCK				
60h	3060h	[7:0]						Ö,							
to	to	to	Set register value th	at descril	oed on item	"Register n	nap".)							
FFh	30FFh	[7:0]					<u>.</u>								
Chip ID =	03h						777								
00h	3100h	[7:0]				~40)								
to	to	to	Set register value that described on item "Register map".												
FFh	31FFh	[7:0]			1										
Chip ID =			T												
00h	3200h	[7:0]			1/2										
to	to	to	Set register value th	Set register value that described on item "Register map".											
FFh	32FFh	2FFh [7:0]													

							CSI-2 serial			Remarks		
Add	ress			11411	A 1/A	A1/A	10 bit	12 bit	10 bit	0.1		
		bit	Register Name	Initial Value	N/A	N/A	*1 and *2	*1 and *2	*3 and *4	2 lane		
4-wire	I ² C			value	10 bit	12 bit	10 bit	12 bit	10 bit	4 lane		
4-Wile	10		*1 and *2							4 laile		
Chip ID =	Chip ID = 05h											
				Data rate	185.625	222.75	371.25	445.5	742.5	[Mbps / Lane]		
44h	3344h	[5:4]	REPETITION	0h	2h	1h	1h	0h	0h	_		
46h	3346h	[1:0]	PHYSICAL_ LANE_NUM	3h			1h / 3h			1h : 2 lane 3h : 4 lane		
53h	3353h	[5:0]	OB_SIZE_V	Eh			Eh			_		
57h	3357h	[7:0]	DIO 0175 V				449h					
58h	3358h	[4:0]	PIC_SIZE_V	449h			_					
6Bh	336Bh	[7:0]	THSEXIT	3Fh	27h	2Fh	Global timing					
6Ch	336Ch	[7:0]	TCLKPRE	1Fh			Global timing					
7Dh	337Dh	[7:0]					0A0Ah: RAW10					
7Eh	337Eh	[7:0]	CSI_DT_FMT	0C0Ch			0C0Ch: RAW12					
7Fh	337Fh	[1:0]	CSI_LANE_	3h			1h : 2 lane					
			MODE				3h : 4 lane					
80h	3380h	[7:0]					Set according to INCK					
81h	3381h	[7:0]	INCK_FREQ1	4A40h		74.25						
82h	3382h	[7:0]	TCLKPOST	67h	57h	5Fh	5Fh	67h	77h	Global timing		
83h	3383h	[7:0]	THSPREPARE	1Fh	0Fh	17h	1Fh	1Fh	2Fh	Global timing		
84h	3384h	[7:0]	THSZERO	3Fh	2Fh	2Fh	37h	3Fh	5Fh	Global timing		
85h	3385h	[7:0]	THSTRAIL	27h	17h	17h	1Fh	27h	37h	Global timing		
86h	3386h	[7:0]	TCLKTRAIL	1Fh	0Fh	17h	1Fh	1Fh	37h	Global timing		
87h	3387h	[7:0]	TCLKPREPARE	17h	0Fh	0Fh	17h	17h	37h	Global timing		
88h	3388h	[7:0]	TCLKZERO	77h	37h	4Fh	67h	77h	BFh	Global timing		
89h	3389h	[7:0]	TLPX	27h	1Fh	2 7h	27h	27h	3Fh	Global timing		
8Dh	338Dh	[7:0]	INCK_FREQ2	0367h	*et	37.125	Set according to INCK					
8Eh	338Eh	[7:0]		300.71	74.25 MHz: 0367h					Set according to INCK		

The example of window cropping setting is shown below.

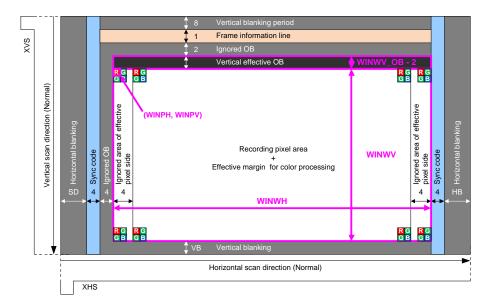
The frame rate is maximum setting as each image format. For adjust the frame rate, please extend the VMAX or the number of lines per frame.

Example of Window cropping Mode Setting

Image	INCK	Output Resolution	Frame rate [frame/s]	Number of recording pixels		Register setting [DEC] (HEX)						
size	[MHz]	[bit]		Horizontal	Vertical	FRSEL	НМАХ	VMAX	WINPH	WINPV	WINWH	WINWV
		10/12	63.9			2	4400d (1130h)	520d (208h)				
VGA	37.125 74.25	10/12	129.8	640	480	1	2200d (898h)		640d (280h)	300d (12Ch)	656d (290h)	496d (1F0h)
		10	259.6			0	1100d (44Ch)					
		10/12	102.9			2	4400d (1130h)					
CIF	37.125 74.25	10/12	205.8	352	288	1	2200d (898h)	328d (148h)	784d (310h)	396d (18Ch)	368d (170h)	304d (130h)
		10	411.6			0	1100d (44Ch)	9.				

^{*} These settings are when the ignored OB line is 2 lines and effective OB line is 14 lines.

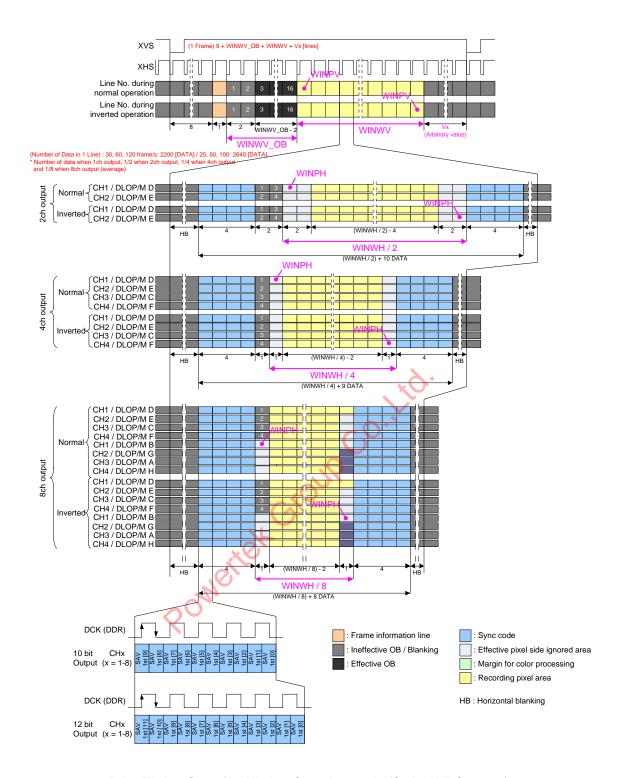
^{*} When the CSI-2 output, set the value that is set to register WINWV to register PIC_SIZE_V.



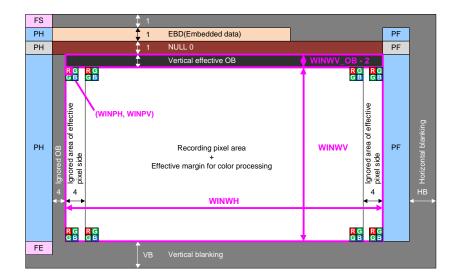
Pixel Array Image Drawing in Window Cropping mode (Serial LVDS output)



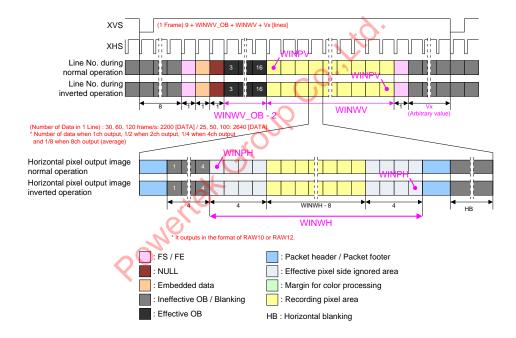
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Drive Timing Chart for Window Cropping mode (Serial LVDS output)



Pixel Array Image Drawing in Window Cropping mode (CSI-2 serial output)



Drive Timing Chart for Window Cropping mode (CSI-2 serial output)

Description of Various Function

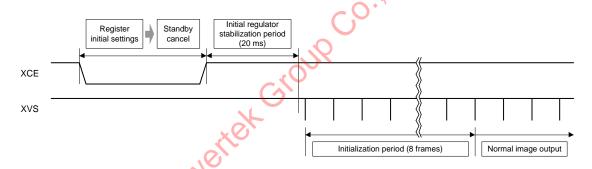
Standby Mode

This sensor stops its operation and goes into standby mode which reduces the power consumption by writing "1" to the standby control STANDBY register. Standby mode is also established after power-on or other system reset operation.

List of Standby Mode Setting

	Register details				1:4:1	0 - 44:			
Register name	Register Chip ID		Address (): I ² C	bit	Initial value	Setting value	Status	Remarks	
STANDBY		02h	00h	[0]	1	1	Standby	Register communication is executed in standby mode.	
STAINDBY	_	UZN	(3000h)	[0]	1	0	Operating		

The serial communication registers hold the previous values. However, the address registers transmitted in standby mode are overwritten. The serial communication block operates even in standby mode, so standby mode can be canceled by setting the STANDBY register to "0". Some time is required for sensor internal circuit stabilization after standby mode is canceled. After standby mode is canceled, a normal image is output from the 9 frames after internal regulator stabilization (20 ms or more).



Sequence from Standby Cancel to Stable Image Output

Slave Mode and Master Mode

The sensor can be switched between slave mode and master mode. The switching is made by the XMASTER pin. Establish the XMASTER pin status before canceling the system reset. (Do not switch this pin status during operation.)

Input a vertical sync signal to XVS and input a horizontal sync signal to XHS when a sensor is in slave mode. For sync signal interval, input data lines to output for vertical sync signal and 1H period designated in each operating mode for horizontal sync signal. See the section of "Operating mode" for the number of output data line and 1H period.

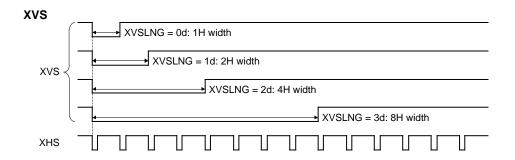
Set the XMSTA register to "0" in order to start the operation after setting to master mode. In addition, set the count number of sync signal in vertical direction by the VMAX [16:0] register and the clock number in horizontal direction by the HMAX [13:0] register. See the description of Operation Mode for details of the section of "Operating Modes".

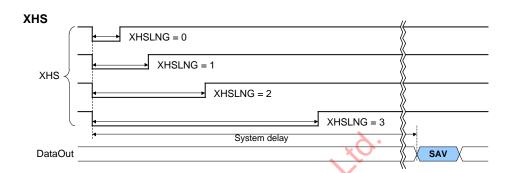
List of Slave and Master Mode Setting

Pin name	Pin processing	Operating mode	Remarks		
VMACTED nin	Fixed to Low	Master mode	High: OV _{DD} Low: GND		
XMASTER pin	Fixed to High	Slave mode			

List of Register in Master Mode

	Register detail	s (Chip ID	= 02h)	Initial			
Register name	Register	Address (): I ² C	bit	value	Setting value	Remarks	
XMSTA	_	02h (3002h)	[0]	1	Master operation ready Master operation start	The master operation starts by setting 0.	
	VMAX [7:0]	18h (3018h) [7:0		9,			
VMAX [16:0]	VMAX [15:8]	19h (3019h)	[7:0]	00465h	See the item of each drive mode.	Line number per frame designated	
	VMAX [16]	1Ah (301Ah)	[0]				
HMAX [13:0]	HMAX [7:0]	1Bh (301Bh)	[7:0]	0898h	See the item of each drive mode.	Clock number per line	
[10.0]	HMAX [13:8]	1Ch (301Ch)	[5:0]	009011	See the item of each drive mode.	designated	
XVSLNG [1:0]	R	46h (3046h)	[5:4]	0h	0: 1H, 1: 2H, 2: 4H, 3: 8H	XVS low level pulse width designated	
XHSLNG [1:0]	1	47h (3047h)	[5:4]	0h	0: Min.to 3: Max. See the next	XHS low level pulse width designated	
XVSOUTSEL [1:0]	— 49h		[1:0]	0h	Fixed to High VSYNC output Others: Setting prohibited	_	
XHSOUTSEL [1:0]	_	(3049h)	[3:2]	0h	0: Fixed to High 2: HSYNC output Others: Setting prohibited	_	





XVS/XHS output waveform in sensor master mode

List of XHSLNG Register

	LVDS serial output									
DCK	445.5	371.25	222.75	185.625	111.375	92.8125				
DCK	[Mbps / ch] [Mbps / ch]		[Mbps / ch]	[Mbps / ch]	[Mbps / ch]	[Mbps / ch]				
XHSLNG = 0	48 bit	40 bit	24 bit	20 bit	12 bit	10 bit				
XHSLNG = 1	96 bit	80 bit	48 bit	40 bit	24 bit	20 bit				
XHSLNG = 2	192 bit	160 bit	96 bit	80 bit	48 bit	40 bit				
XHSLNG = 3	384 bit 🧹	320 bit	192 bit	160 bit	96 bit	80 bit				

The XVS and XHS are output in timing that set 0 to the register XMSTA. If set 0 to XMSTA during standby, the XVS and XHS are output just after standby is released. The XVS and XHS are output asynchronous with other input or output signals. In addition, the output signals are output with a undefined latency time (system delay) relative to the XHS. Therefore, refer to the sync codes output from the sensor and perform synchronization.

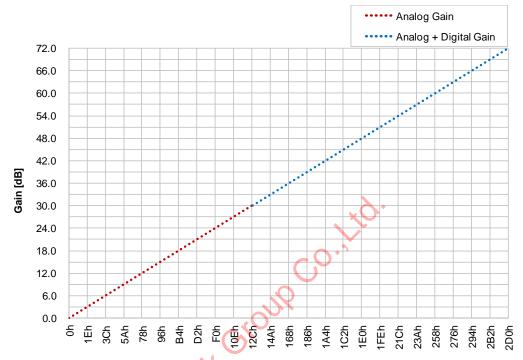
SONY IMX385LQR-C

Gain Adjustment Function

The Programmable Gain Control (PGC) of this device consists of the analog block and digital block. The total of analog gain and digital gain can be set up to 72 dB by the GAIN [9:0] register setting. The same setting is applied in all colors. The value which is ten times the gain is set to register.

Example)

When set to 6 dB: $6 \times 10 = 60d$; GAIN [9:0] = 3Ch When set to 12.8 dB: $12.8 \times 10 = 128d$; GAIN [9:0] = 80h

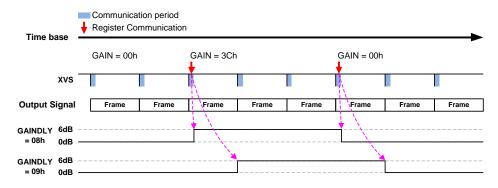


Register setting value [Hex]

List of PGC Register

Register name	Register deta	ils (Chip ID =	02h)	Initial	Setting value	Remarks	
	Register	Address (): I ² C	bit	value	Setting range	Remarks	
CAINI [0:0]	GAIN [7:0]	14h (3014h)	[7:0]	000h	000h-2D0h	Setting value: Gain [dB] × 10	
GAIN [9:0]	GAIN [9:8]	15h (3015h)	[1:0]	- 000h	(0d-720d)		

Gain Reflection Timing is changed by the set value of GAINDLY as shown below.



Gain Reflection Timing

Black Level Adjustment Function

The black level offset (offset variable range: 000h to 1FFh) can be added relative to the data in which the digital gain modulation was performed by the BLKLEVEL [8:0] register. When the BLKLEVEL setting is increased by 1 LSB, the black level is increased by 1 LSB.

Use with values shown below is recommended.

10-bit output: 03Ch (60d) 12-bit output: 0F0h (240d)

List of Black Level Adjustment Register

	Register detai	Is (Chip ID = 02h)		Initial		
Register name	Register	Address (): I ² C	bit	value	Setting value	
	BLKLEVEL [7:0]	0Ah (300Ah)	[7:0]	0F0h	000h to 1FFh	
BLKLEVEL [8:0]	BLKLEVEL [8]	0Bh (300Bh)	[0]	OFUN	סטטוונט ודרוו	



Normal Operation and Inverted Operation

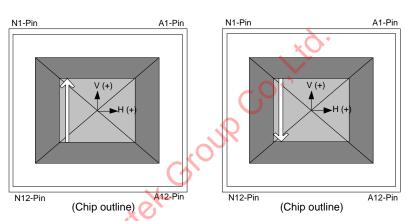
The sensor readout direction (normal / inverted) in vertical direction can be switched by the VREVERSE register setting and in horizontal direction can be switched by the HREVERSE register setting. See the section of "Operating Modes" for the order of readout lines in normal and inverted modes. One invalid frame is generated when reading immediately after the readout direction change in order to switch the normal operation and inversion between frames.

List of Drive Direction Setting Register

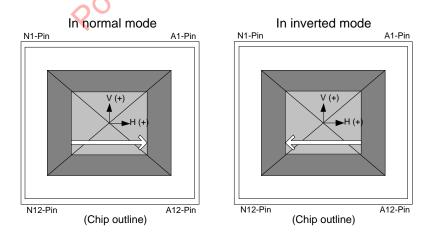
	Register detai	Is (Chip ID = 02h)		Initial		
Register name	Register	Address (): I ² C	bit	value	Setting value	
VREVERSE	_	07h	[0]	0h	0: Normal (Initial value) 1: Vertical Inverted	
HREVERSE	_	(3007h)	[1]	0h	0: Normal (Initial value) 1: Horizontal Inverted	



In inverted mode



Normal and Inverted Drive Outline in Vertical Direction (TOP VIEW)



Normal and Inverted Drive Outline in Horizontal Direction (TOP VIEW)

Shutter and Integration Time Settings

This sensor has a variable electronic shutter function that can control the integration time in line units. In addition, this sensor performs rolling shutter operation in which electronic shutter and readout operation are performed sequentially for each line.

Note) For integration time control, an image which reflects the setting is output from the frame after the setting changes.

Example of Integration Time Setting

The sensor's integration time is obtained by the following formula.

Integration time = 1 frame period - (SHS1 + 1) \times (1H period)

- *1 The frame period is determined by the input XVS when the sensor is operating in slave mode, or the register VMAX value in master mode. The frame period is designated in 1H units, so the time is determined by (Number of lines × 1H period).
- *2 See "Operating Modes" for the 1H period.

In this section, the shutter operation and storage time are shown as in the figure below with the time sequence on the horizontal axis and the vertical address on the vertical axis. For simplification, shutter and readout operation are noted in line units.

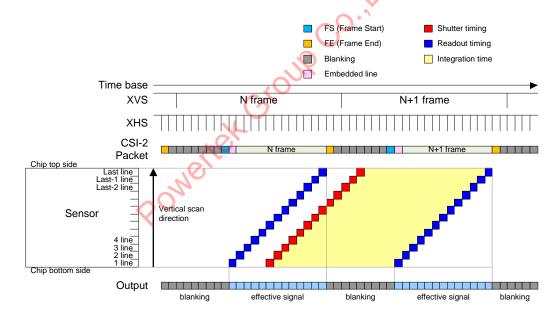


Image Drawing of Shutter Operation

Normal Exposure Operation (Controlling the Integration Time in 1H Units)

The integration time can be controlled by varying the electronic shutter timing. In the electronic shutter settings, the integration time is controlled by the SHS1 [16:0] register. Set SHS1 [16:0] to a value between 2 and (Number of lines per frame - 1). When the sensor is operating in slave mode, the number of lines per frame is determined by the XVS interval (number of lines), using the input XHS interval as the line unit.

When the sensor is operating in master mode, the number of lines per frame is determined by the VMAX register. The number of lines per frame differs according to the operating mode.

List of integration time setting register in 1 H unit

	List of integration time setting register in 111 unit						
	Register deta	ails (Chip ID =	= 02h)				
Register name	Register	Address		Initial value	Setting value		
	SHS1 [7:0]	20h (3020h)	[7:0]				
SHS1 [16:0]	SHS1 [15:8]	21h (3021h)	[7:0]	00000h	Sets the shutter sweep time. 2 to (Number of lines per frame - 2) * Number of lines per frame -1 setting is prohibited		
	SHS1 [16] 22h [0]	3.4					
	VMAX [7:0]	18h (3018h)	[7:0]		10 .		
VMAX [16:0]	VMAX [15:8]	19h (3019h)	[7:0]	00465h	Sets the number of lines per frame (only in master mode). See "Operating Modes" for the setting value in each mode.		
	VMAX [16]	1Ah (301Ah)	[0]	NR			
_	Readout timing	Integr	ation time		S (Frame Start) Embedded Data		
	Shutter timing	Comn	nunication p	eriod F	E (Frame End) Blanking		
Time base -			3		-		
XVS	SHS1= α	SHS1=β		.	1		
XHS							
CSI-2 Packet							
Vertical scan direction $\alpha+1$ Frame2 $\beta+1$ Frame3 $\beta+1$ Frame4 $\beta+1$ Frame5 integration time integration time integration time							
Output timimg_	V-BLK Frame1	V-BLK Fra	me2 V	-BLK Frame:	3 V-BLK Frame4 V-BLK Frame5		

Image Drawing of Integration Time Control within a Frame

Long Exposure Operation (Control by Expanding the Number of Lines per Frame)

Long exposure operation can be performed by lengthening the frame period.

When the sensor is operating in slave mode, this is done by lengthening the input vertical sync signal (XVS) pulse interval. When the sensor is operating in master mode, it is done by designating a larger register VMAX [16:0] value compared to normal operation. When the integration time is extended by increasing the number of lines, the rear V blanking increases by an equivalent amount. The maximum VMAX and SHS1 [16:0] values are 131071d. When the number of lines per frame is set to the maximum value, the integration time in All-pixel scan mode at 60 frame / s is approximately 1.9 s. However, set the upper limit of the long exposure operation to be one second. When set to a number of V lines or more than that noted for each operating mode, the imaging characteristics are not guaranteed during long exposure operation.

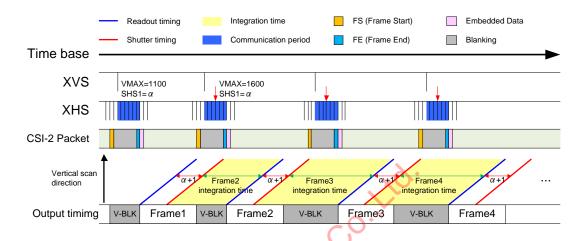


Image Drawing of Long Integration Time Control by Adjusting the Frame Period

Example of Integration Time Settings

The example of register setting for controlling the storage time is shown below.

Example of Integration Time Settings (In All-pixel scan)

Onevetica	Sensor setti	ng (register)	late metica time
Operation	VMAX* SHS1**		Integration time
		1125	Setting prohibited
		1124	Setting prohibited
		1123	1H
		:	:
Normal frame rate	1125	N	(1125 - (N + 1)) H
		:	:
		2	1122H
		1	Setting prohibited
		0	Setting prohibited
Long time exposure Operation (Control by Expanding the Number of Lines per Frame)	М	N	(M - (N + 1) H

^{*} In sensor master mode. In slave mode, the interval is the same as XVS input.

^{**} The SHS1 setting value (N) is set between "2" and "the VMAX value (M) - 2".

Signal Output

Output Pin Settings

The output formats of this sensor support the following modes.

Low voltage LVDS serial (2 ch / 4 ch / 8 ch switching) DDR output CSI-2 serial (2 Lane / 4 Lane, RAW10 / RAW12) output

The switching for serial interface is made by the OMODE pin. Establish the OMODE pin status before canceling the system reset. (Do not switch this pin status during operation.) Each mode is set using the register OPORTSEL. The table below shows the output format settings.

List of Interface Switching

Pin name	Pin	Interface	Remarks
OMODE pin	Fixed to Low	CSI-2 serial	High: OVDD
ONIODE PIN	Fixed to High	Low voltage LVDS serial	Low: GND

List of Output Interface Setting Register

Pogistor namo	Register d (Chip ID =	02h) Initial		Setting	Doccription
Register name	Address (): I ² C	bit	value	value	Description
				Dh	Low voltage LVDS serial 2 ch DDR
	4.41			Eh	Low voltage LVDS serial 4 ch DDR
OPORTSEL [3:0]	OPORTSEL [3:0] 44h (3044h)	[7:4]	0h	Fh	Low voltage LVDS serial 8 ch DDR
				0h	CSI-2 serial 2Lane
			~ (O	0h	CSI-2 serial 4Lane
SCDEN	54h	VIOI.	(),	0h	Sync code Disable (In CSI-2, must set to 0h.)
SCDEN	(3054h)	×[0]	1h	1h	Sync code Enable (Low voltage LVDS serial, must set to 1h.)

^{*} In CSI-2 output, set registers that described in section "CSI-2 output setting".

Each output pin is shown in the table below when setting low-voltage LVDS serial 2 ch / 4 ch / 8 ch output.

Output Pins for Low voltage LVDS Serial

	Low voltage LVDS serial DDR output						
DLOP/DLOM	2 ch	4 ch	8 ch				
DLOMH	Hi-Z	Hi-Z	Ch8 / M				
DLOPH	Hi-Z	Hi-Z	Ch8 / P				
DLOMG	Hi-Z	Hi-Z	Ch6 / M				
DLOPG	Hi-Z	Hi-Z	Ch6 / P				
DLOMF	Hi-Z	Ch4 / M	Ch4 / M				
DLOPF	Hi-Z	Ch4 / P	Ch4 / P				
DLOME	Ch2/M	Ch2 / M	Ch2/M				
DLOPE	Ch2 / P	Ch2 / P	Ch2 / P				
DLOMD	Ch1 / M	Ch1 / M	Ch1 / M				
DLOPD	Ch1 / P	Ch1 / P	Ch1 / P				
DLOMC	Hi-Z	Ch3 / M	Ch3 / M				
DLOPC	Hi-Z	Ch3 / P	Ch3 / P				
DLOMB	Hi-Z	Hi-Z	Ch5 / M				
DLOPB	Hi-Z	Hi-Z	Ch5 / P				
DLOMA	Hi-Z	Hi-Z	Ch7 / M				
DLOPA	Hi-Z	Hi-Z	Ch7 / P				
	Romer	iek Clon	X				

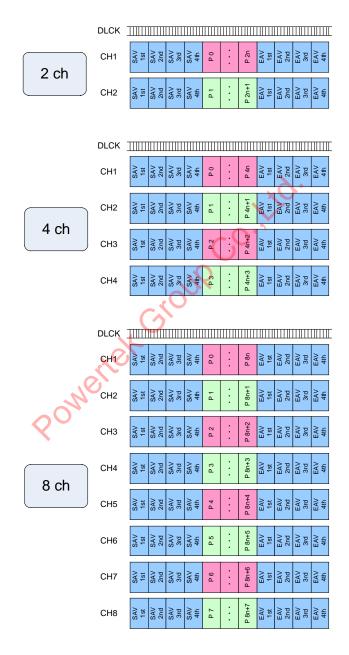
Low-voltage LVDS serial 2 ch / 4 ch / 8 ch output format is shown in the figure below.

When setting 2 ch, after four data of SAV is output in the order of CH1 and CH2 pixel data is repeatedly output in the same order and then four data of EAV is output in the same order to CH1 and CH2 respectively.

When setting 4 ch, after four data of SAV is output in the order of CH1, CH2, CH3 and CH4 pixel data is repeatedly output in the same order and then four data of EAV is output in the same order to CH1, CH2, CH3 and CH4 respectively.

When setting 8 ch, output in a format similar to the 2 ch and 4 ch output as shown below. Data is sent MSB first.

For details, see drive timing in each mode in the section of "Operation Mode".



Output Format of Low voltage LVDS Serial 2 ch / 4 ch / 8 ch

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CSI-2 output

The output formats of this sensor support the following modes.

CSI-2 serial 2 Lane / 4 Lane, RAW10 / RAW12

The 2 Lane / 4 Lane serial signal output method using this sensor is described below.

Complied with the CSI-2, data is output using 2 Lane / 4 Lane. The image data is output from the CSI-2 output pin. The DMOPA/DMOMA are called the Lane1 data signal, the DMOPB/DMOMB are called the Lane2 data signal, the DMOPD/DMOMD are called the Lane4 data signal. In addition, the clock signals are output from DMCKP/DMCKM of the CSI-2 pins.

In 2 Lane mode, data is output from Lane1 and Lane2. In 4 Lane mode, data is output from Lane1, Lane2, Lane3 and Lane4. The bit rate maximum value is 742.5 Mbps / Lane.

The select of RAW10 / RAW12 is set by the register: CSI_DT_FMT [15:0].

The number of output lanes is set by the register: CSI_LANE_MODE [1:0] and the number of lanes physically connected is set by PHYSICAL_LANE_NUM [1:0]. Unused lanes (when setting 2 lanes; DMOPC / DMOMC, DMOPD / DMOMD) are set to Hi-Z output by the setting. When the number of lanes more than CSI_LANE_MODE is set by PHYSICAL_LANE_NUM, unused lanes output signals conformed to MIPI standard.

Register name	Register details (Chip ID = 05h)		Initial	Setting	Description	
Register name	Address (): I ² C	bit	value	value	Description	
CSI DT EMT[45:0]	7Dh (337Dh)	[7:0]	oCoCh	0A0Ah	RAW10	
CSI_DT_FMT [15:0]	7Eh (337Eh)	[7:0]	0C0Ch	0C0Ch	RAW12	
			5	0h	Setting prohibited	
PHYSICAL_LANE_NUM [1:0]	46h	[4.0]	3h	1h	2Lane	
FTTTSICAL_LAINE_INDIW[T:0]	(3346h)	[1:0]		2h	Setting prohibited	
				3h	4Lane	
				0h	Setting prohibited	
CSI_LANE_MODE [1:0]	7Fh (337Fh)	[1:0]	3h	1h	2Lane	
				2h	Setting prohibited	
	.0)			3h	4Lane	

The formats of RAW12 and RAW10 are shown below.

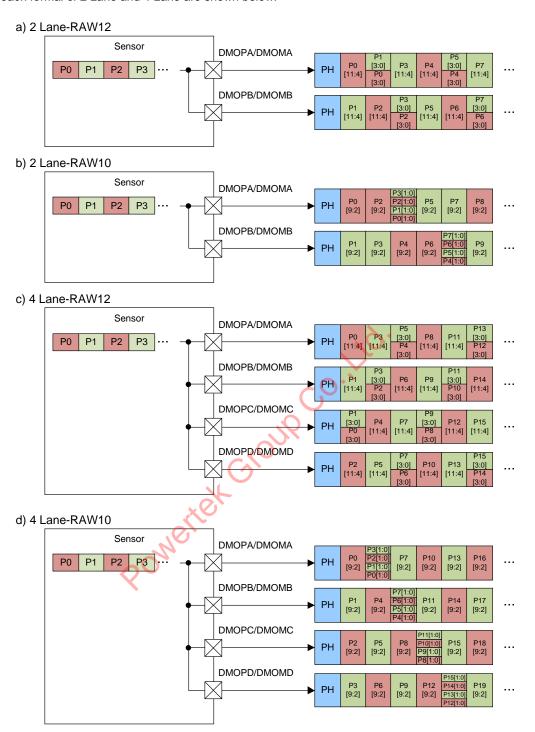


→ RAW12 Format

→ RAW10 Format

The Example of Format of RAW12 / RAW10

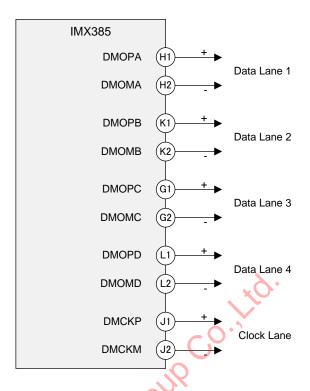
The each formal of 2 Lane and 4 Lane are shown below.



2 Lane / 4 Lane Output Format

MIPI Transmitter

Output pins (DMOPA, DMOMA, DMOPB, DMOMB, DMOPC, DMOMC, DMOPD, DMOMD, DMCKP, DMCKM) are described in this section.

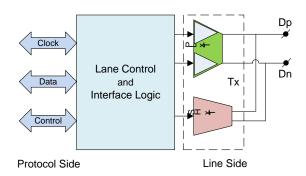


Relationship between Pin Name and MIPI Output Lane

The pixel signals are output by the CSI-2 High-speed serial interface. See the MIPI Standard

- MIPI Alliance Standard for Camera Serial Interface 2 (CSI-2) Version 1.01.00
- MIPI Alliance Specification for D-PHY Version 1.00.00

The CSI-2 transfers one bit with a pair of differential signals. The transmitter outputs differential current signal after converting pixel signals to it. Insert external resistance in differential pair in a series or use cells with a built-in resistance on the Receiver side. When inserting an external resistor, as close as possible to the Receiver. The differential signals maintain a constant interval and reach the receiver with the shortest wiring length possible to avoid malfunction. The maximum bit rate of each Lane are 742.5 Mbps / Lane.



Universal Lane Module Functions

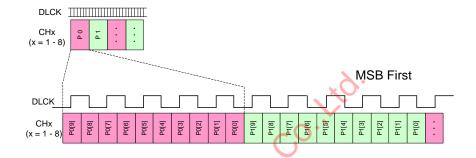
Output Pin Bit Width Selection

The output pin width can be selected from 10-bit or 12-bit output using the register ODBIT. When low-voltage LVDS serial output, continuous data is output MSB first by 10-bit and 12-bit output setting respectively. 10-bits sync code are output when ODBIT = 0 (10-bit output), and 12-bit sync codes are output when ODBIT = 1 (12-bit output).

Output Pin Bit Width Selection Setting Register

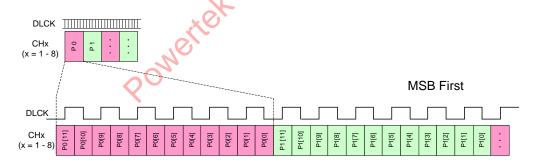
Register	Register de	etails (Chip ID = 02	h)	Initial	
name	Register Address (): I ² C		bit	value	Setting value
ODBIT	_	44h (3044h)	[0]	0h	0: 10 bit 1: 12 bit

ODBIT = 0 (Low voltage LVDS serial 10 bit output)



Example of Data format in low-voltage LVDS serial 10-bit output

ODBIT = 1 (Low voltage LVDS serial 12 bit output)



Example of Data format in low-voltage LVDS serial 12-bit output

Number of Internal A/D Conversion Bits Setting

The number of internal A/D conversion bits can be selected from 10 bits or 12 bits by the register ADBIT. See the section of "Operating Modes" for the correspondence with each mode.

List of Bit Width Selection

Pogistor	Register de	tails (Chip ID = 02	2h)		
Register name	L Address		bit	Initial value	Setting value
ADBIT	_	05h (3005h)	[0]	1h	0: 10 bit 1: 12 bit

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Output Rate Setting

The sensor output rate is determined uniformly by the sensor operating mode and the output format. See the section of "Operating Modes" for the relationship between each setting and the frame rate, data rate and data bit rate. The registers related to mode setting are shown in the table below.

Related Registers for Setting Operation Mode

	Register de	etails (Chip ID	e 02h)	Initial	
Register name	Register	Address (): I ² C	bit	value	Setting value
FRSEL [1:0]	_	09h (3009h)	[1:0]	1h	0: 120 frame/s 1: 60 frame/s 2: 30 frame/s 3: Setting prohibited

Output Signal Range

Low voltage LVDS serial

The sensor output has either a 10-bit or 12-bit gradation, but output is not performed over the full range, and the maximum output value is the (3FFh - 1) value (10-bit output) and the (FFFh - 1) one (12-bit output). In addition, the minimum value is 001h. The output range for each output gradation is shown in the table below. See the item of "Sync Codes" in the section of "Operating Modes" for the sync codes.

Output Gradation and Output Range

Output gradation	Output Value					
Output gradation	Min.	Max.				
10 bit	001h	3FEh				
12 bit	001h	FFEh				

CSI-2 serial

The sensor output has either a 10-bit or 12-bit gradation, and the maximum output value is the 3FFh value (10-bit output) and the FFFh one (12-bit output). In addition, the minimum value is 000h. The output range for each output gradation is shown in the table below

Output Gradation and Output Range

Output gradation	Outpu	t Value
Output gradation	Min.	Max.
10 bit	000h	3FFh
12 bit	000h	FFFh

INCK Setting

The available operation mode varies according to INCK frequency. Input either 37.125 MHz or 74.25 MHz for INCK frequency. The INCK setting register and the list of INCK setting are shown in the table below.

INCK Setting Register

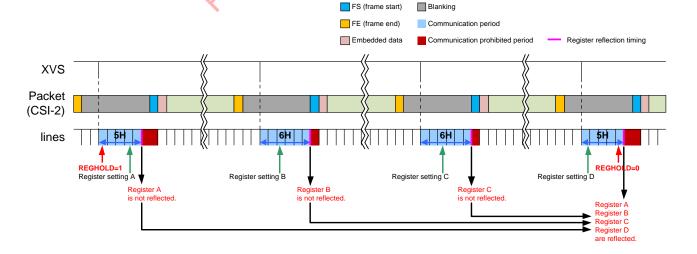
	Register details (Chip ID = 02h)			Initial	INCK			
Register name	Dogistor	Address	bit	value	37.125 [MHz]		74.25 [MHz]	
	Register	(): I ² C	DIL	*4:40	10 bit	12 bit	10 bit	12 bit
INCKSEL1	_	5Ch (305Ch)	[7:0]	18h	28h	18h	28h	18h
INCKSEL2	_	5Dh (305Dh)	[7:0]	10h	00)h	10	Oh
INCKSEL3	_	5Eh (305Eh)	[7:0]	20h	20)h	20	Oh
INCKSEL4	_	5Fh (305Fh)	[7:0]	10h	00)h	10	Oh

Register Hold Setting

Register setting can be transmitted with divided to several frames and it can be reflected globally at a certain frame by the register REGHOLD. Setting REGHOLD = 1 at the start of register communication period prevents the registers that are set thereafter from reflecting at the frame reflection timing. The registers that are set when setting REGHOLD = 1 are reflected globally by setting REGHOLD = 0 at the end of communication period of the desired frame to reflect the register. In case of communicate to REGHOLD register only, communication period will be 5H and communication prohibited period will be 2H.

Register Hold Setting Register

Degister	Register details (Chip ID = 02h)			Initial		
Register name	Register	Address ():1 ² C	bit	value	Setting value	
REGHOLD	_	01h (3001h)	[0]	0h	0: Invalid 1: Valid (Register hold)	



Register Hold Setting

Software Reset (Low voltage LVDS serial only)

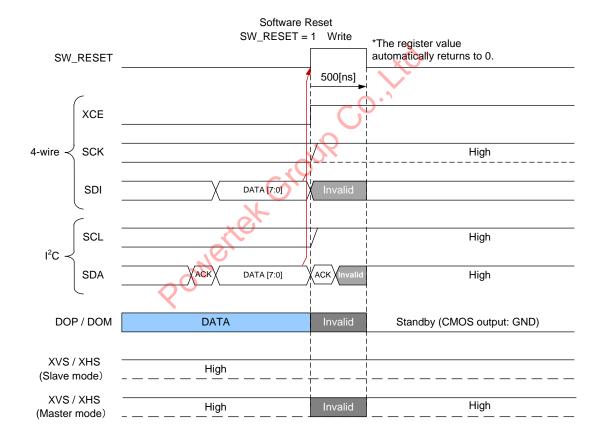
This function is prohibited in CSI-2 output mode.

Software reset can be performed by register setting using the register SW_RESET.

Sensor reset is performed by setting SW_RESET = 1. However, the communication to continuous address cannot use. The registers become initial state and standby 500 ns after setting SW_RESET = 1. The SW_RESET signal returns to "0" automatically. DLOPA-H / DLOMA-H / DLCKP / DLCKM pins will become standby state of Hi-Z. The XVS and XHS output High in master mode. Input High to the XVS and XHS before setting SW_RESET = 1 in slave mode. Follow the sequence in the item of "Standby Mode" to perform register initial setting and standby cancel from standby state.

Software Reset Register Setting

Register	Register det	ails (Chip ID = 0	2h)		
name	Register	Address (): I ² C	bit	Initial value	Setting value
SW_RESET	_	03h (3003h)	[0]	0h	0: Normal Operation 1: Reset



Software Reset

Mode Transitions

When changing the operating mode during sensor drive operation, set via sensor standby. However, these transitions that described below can be transitions without standby.

- ◆ Change the number of vertical lines (In sensor master mode, change the VMAX. In sensor slave mode, change the period of XVS input.)
- ◆ Horizontal and vertical scan direction. (When the vertical scan direction is changed, an invalid frame generates during transition.)
- ◆ Change the HCG mode and LCG mode.

When changing input INCK frequency (register INCKSEL1, INCKSEL2, INCKSEL3, and INCKSEL4 change) or when operating mode transition that changes output bit width (register ODBIT) or output format (register OPORTSEL [3:0]), always start the operation via sensor standby after changing mode during standby following the standby cancel sequence.

When changing input INCK frequency, care should be taken not to be input pulses whose width are shorter than the High / Low level width in front and behind of the INCK pulse at the frequency change. If the pulses above generate at the frequency change, change INCK frequency during system reset in the state of XCLR = Low, and then perform system clear in the state of XCLR = High following the item of "Power on sequence" in the section of "Power on / off sequence". Execute initial setting again because the register settings become default state after system clear.

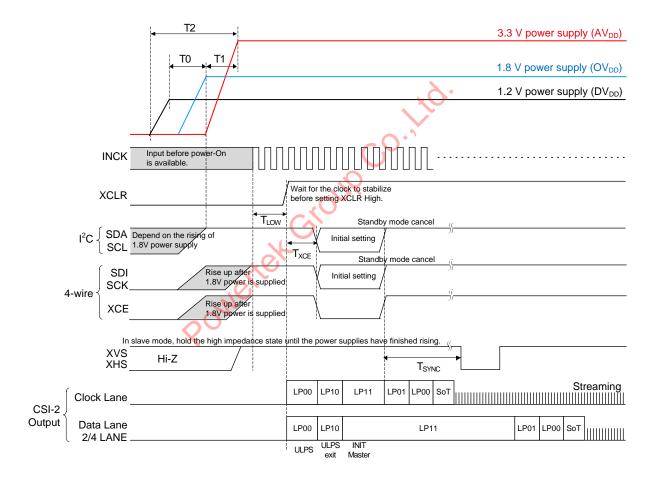
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Power-on and Power-off Sequence

Power-on sequence

Turn On the power supplies so that the power supplies rise in order of 1.2 V power supply (DVDD) → 1.8 V power supply (OVDD) → 3.3 V power supply (AVDD). In addition, all power supplies should finish rising within 200 ms.

- 2. Start master clock (INCK) input after turning On the power supplies.
- 3. The register values are undefined immediately after power-on, so the system must be cleared. Hold XCLR at Low level for 500 ns or more after all the power supplies have finished rising. (The register values after a system clear are the default values.) In addition, hold XCE to High level during this period. Rise XCE after 1.8 V power supply (OVDD).
- 4. The system clear is applied by setting XCLR to High level. However, the maser clock needs to stabilize before setting the XCLR pin to High level.
- Make the sensor setting by register communication after the system clear. A period of 20 μs or more should be provided after setting XCLR High before inputting the communication enable signal XCE. In I²C communication, XCE is fixed to High.

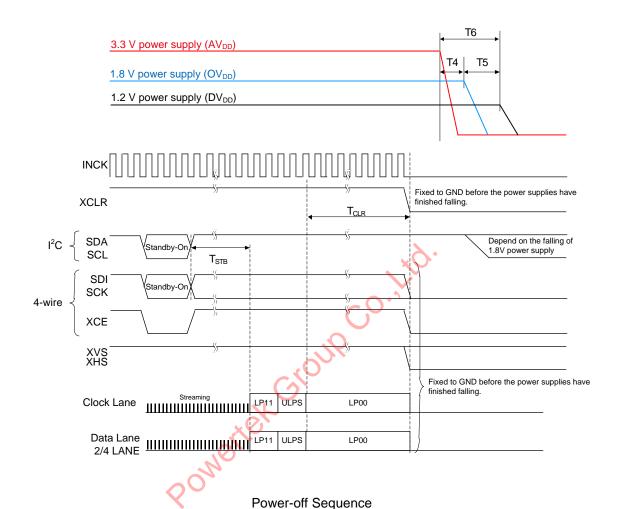


Power-on Sequence

Item	Symbol	Min.	Max.	Unit
1.2 V power supply rising → 1.8 V power supply rising	T0	0		ns
1.8 V power supply rising → 3.3 V power supply rising	T1	0		ns
Rising time of all power supply	T2	ı	200	ms
INCK active → Clear OFF	T_{LOW}	500	_	ns
Clear OFF → Communication start	T _{XCE}	20		μs
Standby OFF (communication)	T _{SYNC}	20		ms
→ External input XHS,XVS (slave mode only)	TSTNC	20		1110

Power-off sequence

Turn Off the power supplies so that the power supplies fall in order of 3.3 V power supply (AVDD) \rightarrow 1.8 V power supply (OVDD) \rightarrow 1.2 V power supply (DVDD). In addition, all power supplies should falling within 200 ms. Set each digital input pin (INCK, XCE, SCK, SDI, XCLR, XMASTER, OMODE, XVS, XHS) to 0 V before the 1.8 V power supply (OVDD) falls.



Item	Symbol	Min.	Max.	Unit
Standby ON (communication) → LP11 mode start	T _{STB}	Until FE		_
LP00 → XCLR falling	T _{CLR}	128	_	cycle
3.3 V power shut down → 1.8 V power shut down	T4	0	_	ns
1.8 V power shut down → 1.2 V power shut down	T5	0	_	ns
Shut down time of all power supply	T6	_	200	ms

Sensor Setting Flow

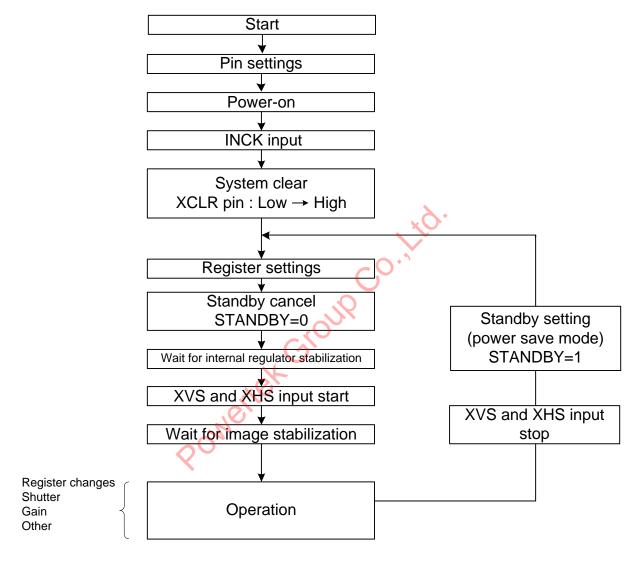
Setting Flow in Sensor Slave Mode

The figure below shows operating flow in sensor slave mode.

For details of "Power-on" to "Reset cancel", see the item of "Power-on sequence" in this section.

For details of "Standby cancel" until "Wait for image stabilization", see the item of "Standby mode".

Standby setting (power save mode) can be made by setting the STANDBY register to "1" during "Operation".



Sensor Setting Flow (Sensor Slave Mode)

Setting Flow in Sensor Master Mode

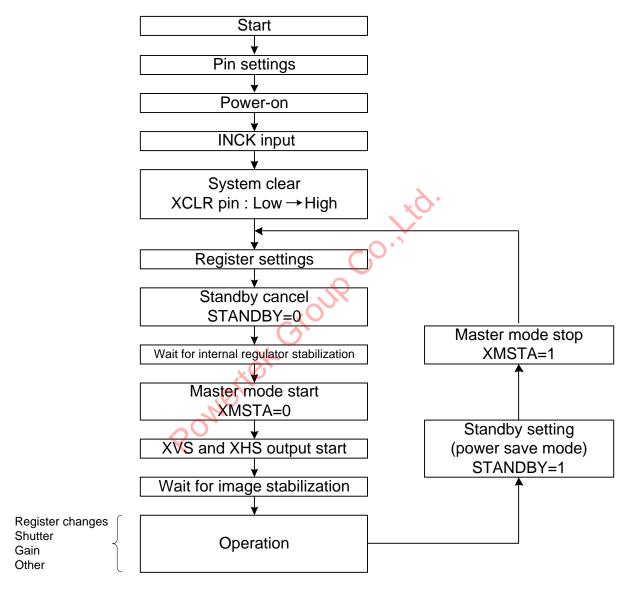
The figure below shows operating flow in sensor master mode.

For details of "Power-on" to "Reset cancel", see the item of "Power on sequence" in this section.

For details of "Standby cancel" until "Wait for image stabilization", see the item of "Standby mode".

In master mode, "Master mode start" by setting register XMSTA to "0" after "Waiting for internal regulator stabilization".

"Standby setting (power save mode) can be made by setting the STANDBY register to "1" during "Operation". This time, set "master mode stop" by setting XMSTA to "1".

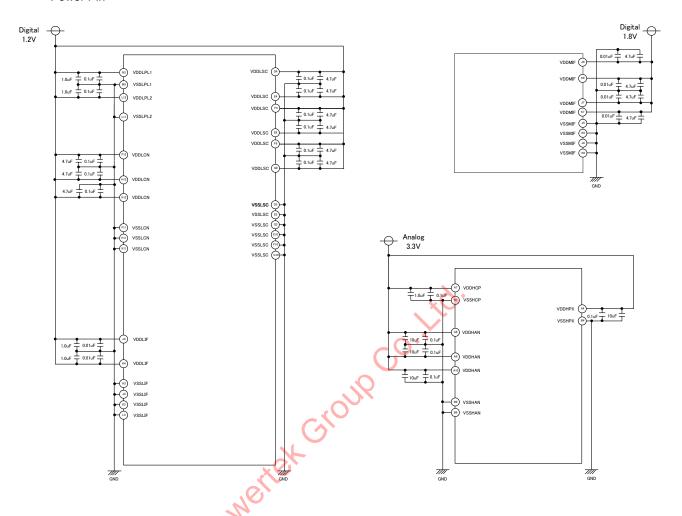


Sensor Setting Flow (Sensor Master Mode)

SONY

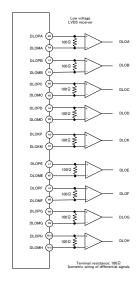
Peripheral Circuit

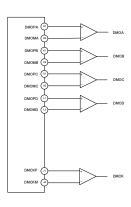
Power Pin



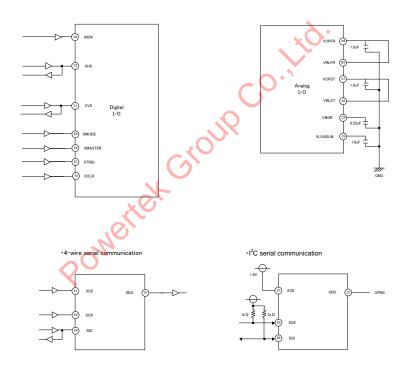
Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party and other right due to same.

Output Pin





IO Pin



Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party and other right due to same.

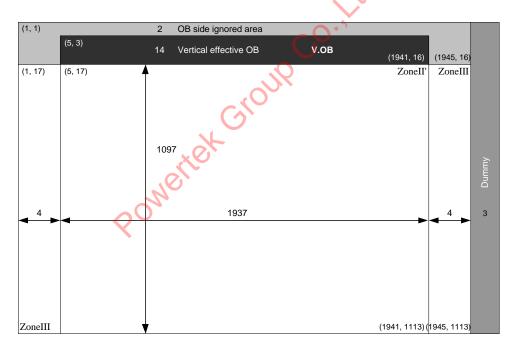
Spot Pixel Specifications

 $(AV_{DD}=3.3~V,~OV_{DD}=1.8~V,~DV_{DD}=1.2~V,~Tj=60~^{\circ}C,~30~frame/s,~Gain:~0~dB,~LCG~mode)$

	Level		Maximum distorted pixels in each zone			Measurement		
Type of distortion			II'	Effective OB	III	Ineffective OB	method	Remarks
Black or white	30 % ≤ D		15	No evaluation		n	1	_
pixels at high light			15	CI	criteria applied		'	
White pixels	5.6 mV ≤ D		20	00	No eva	luation	2	1/20 a ataraga
in the dark			200 criteria applied		applied	2	1/30 s storage	
Black pixels at	D <u><</u> 968 mV		000 \		No evaluation		2	
signal saturated			0	criteria applied		3	_	

- Note) 1. Zone is specified based on all-pixel drive mode
 - 2. D Spot pixel level
 - 3. See the Spot Pixel Pattern Specifications for the specifications in which pixel and black pixel are close.

Zone Definition



Notice on White Pixels Specifications

After delivery inspection of CMOS image sensors, cosmic radiation may distort pixels of CMOS image sensors, and then distorted pixels may cause white point effects in dark signals in picture images. (Such white point effects shall be hereinafter referred to as "White Pixels".) Unfortunately, it is not possible with current scientific technology for CMOS image sensors to prevent such White Pixels. It is recommended that when you use CMOS image sensors, you should consider taking measures against such White Pixels, such as adoption of automatic compensation systems for White Pixels in dark signals and establishment of quality assurance standards. Unless the Seller's liability for White Pixels is otherwise set forth in an agreement between you and the Seller, Sony Semiconductor Solutions Corporation or its distributors (hereinafter collectively referred to as the "Seller") will, at the Seller's expense, replace such CMOS image sensors, in the event the CMOS image sensors delivered by the Seller are found to be to the Seller's satisfaction, to have over the allowable range of White Pixels as set forth above under the heading "Spot Pixels Specifications", within the period of three months after the delivery date of such CMOS image sensors from the Seller to you; provided that the Seller disclaims and will not assume any liability after you have incorporated such CMOS image sensors into other products.

Please be aware that Seller disclaims and will not assume any liability for (1) CMOS image sensors fabricated, altered or modified after delivery to you, (2) CMOS image sensors incorporated into other products, (3) CMOS image sensors shipped to a third party in any form whatsoever, or (4) CMOS image sensors delivered to you over three months ago. Except the above mentioned replacement by Seller, neither Sony Semiconductor Solutions Corporation nor its distributors will assume any liability for White Pixels. Please resolve any problem or trouble arising from or in connection with White Pixels at your costs and expenses.

[For Your Reference] The Annual Number of White Pixels Occurrence

The chart below shows the predictable data on the annual number of White Pixels occurrence in a single-story building in Tokyo at an altitude of 0 meters. It is recommended that you should consider taking measures against the annual White Pixels, such as adoption of automatic compensation systems appropriate for each annual number of White Pixels occurrence.

The data in the chart is based on records of past field tests, and signifies estimated number of White Pixels calculated according to structures and electrical properties of each device. Moreover, the data in the chart is for your reference purpose only, and is not to be used as part of any CMOS image sensor specifications.

Example of Annual Number of Occurrence

White Pixel Level (in case of integration time = $1/30$ (Tj = $60 ^{\circ}$ C/LCG mode)	S) Annual number of occurrence
5.6 mV or higher	27 pcs
10.0 mV or higher	15 pcs
24.0 mV or higher	6 pcs
50.0 mV or higher	3 pcs
72.0 mV or higher	2 pcs

- Note 1) The above data indicates the number of White Pixels occurrence when a CMOS image sensor is left for a year.
- Note 2) The annual number of White Pixels occurrence fluctuates depending on the CMOS image sensor storage environment (such as altitude, geomagnetic latitude and building structure), time (solar activity effects) and so on. Moreover, there may be statistic errors. Please take notice and understand that this is an example of test data with experiments that have being conducted over a specific time period and in a specific environment.
- Note 3) This data does not guarantee the upper limits of the number of White Pixels occurrence.

For Your Reference:

The annual number of White Pixels occurrence at an altitude of 3,000 meters is from 5 to 10 times more than that at an altitude of 0 meters because of the density of the cosmic rays. In addition, in high latitude geographical areas such as London and New York, the density of cosmic rays increases due to a difference in the geomagnetic density, so the annual number of White Pixels occurrence in such areas approximately doubles when compared with that in Tokyo.

Material_No.03-0.0.9

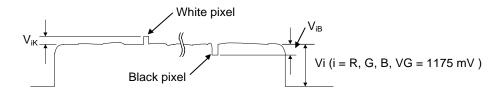
Measurement Method for Spot Pixels

After setting to standard imaging condition II, and the device driver should be set to meet bias and clock voltage conditions. Configure the drive circuit according to the example and measure.

1. Black or white pixels at high light

After adjusting the luminous intensity so that the average value VG of the Gb / Gr signal outputs is 1175 mV, measure the local dip point (black pixel at high light, V_{IB}) and peak point (white pixel at high light, V_{IK}) in the Gr / Gb / R / B signal output Vi (i = Gr / Gb / R / B), and substitute the value into the following formula.

Spot pixel level D = ((ViB or Vik) / Average value of Vi) x 100 [%]



Signal output waveform of R / G / B channel

2. White pixels in the dark

Set the device to a dark setting and measure the local peak point of the signal output waveform, using the average value of the dark signal output as a reference.

3. Black pixels at signal saturated

Set the device to operate in saturation and measure the local dip point, using the OB output as a reference.



Signal output waveform of R / G / B channel

Spot Pixel Pattern Specification

White Pixel, Black Pixel and Bright Pixel are judged from the pattern whether they are allowed or rejected, and counted.

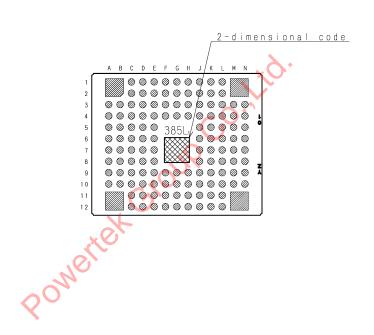
List of White Pixel, Black Pixel and Bright Pixel Pattern

No.	Pattern R G G B	It provides by color filter array described in the left.	White pixel Black pixel Bright pixel
1		Same color	Rejected
2		Same color	Rejected

Note)

- 1." •" shows the position of white pixel, black pixel and bright pixel.
 White pixel, black pixel and bright pixel are specified separately according the pattern.
 (Example: If a black pixel and a white pixel is in the pattern No.1 respectively, they are not judged to be rejected.)
- 2. When one or more spot pixels indicated "Rejected" is selected and removed.
- 3. Spot pixels other than described in the table above are all counted including the number of allowable spot pixels by zone.

Marking



Note: Following characters enter into "Y", and "Z". (No Au coat) Y: In English upper case character, One character Z: Number, single number

DRAWING No. AM-B385LQR (2D)

Notes On Handling

1. Static charge prevention

Image sensors are easily damaged by static discharge. Before handling be sure to take the following protective measures.

- (1) Either handle bare handed or use non-chargeable gloves, clothes or material. Also use conductive shoes.
- (2) Use a wrist strap when handling directly.
- (3) Install grounded conductive mats on the floor and working table to prevent the generation of static electricity.
- (4) Ionized air is recommended for discharge when handling image sensors.
- (5) For the shipment of mounted boards, use boxes treated for the prevention of static charges.

2. Protection from dust and dirt

Image sensors are packed and delivered with care taken to protect the element glass surfaces from harmful dust and dirt. Clean glass surfaces with the following operations as required before use.

- (1) Perform all lens assembly and other work in a clean environment (class 1000 or less).
- (2) Do not touch the glass surface with hand and make any object contact with it. If dust or other is stuck to a glass surface, blow it off with an air blower. (For dust stuck through static electricity, ionized air is recommended.)
- (3) Clean with a cotton swab with ethyl alcohol if grease stained. Be careful not to scratch the glass.
- (4) Keep in a dedicated case to protect from dust and dirt. To prevent dew condensation, preheat or precool when moving to a room with great temperature differences.
- (5) When a protective tape is applied before shipping, remove the tape applied for electrostatic protection just before use. Do not reuse the tape.

3. Installing (attaching)

- (1) If a load is applied to the entire surface by a hard component, bending stress may be generated and the package may fracture, etc., depending on the flatness of the bottom of the package.

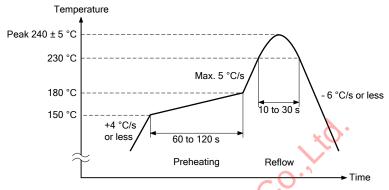
 Therefore, for installation, use either an elastic load, such as a spring plate, or an adhesive.
- (2) The adhesive may cause the marking on the rear surface to disappear.
- (3) If metal, etc., clash or rub against the package surface, the package may chip or fragment and generate dust.
- (4) Acrylate anaerobic adhesives are generally used to attach this product. In addition, cyanoacrylate instantaneous adhesives are sometimes used jointly with acrylate anaerobic adhesives to hold the product in place until the adhesive completely hardens. (Reference)
- (5) Note that the sensor may be damaged when using ultraviolet ray and infrared laser for mounting it.

4. Recommended reflow soldering conditions

The following items should be observed for reflow soldering.

(1) Temperature profile for reflow soldering

Control item	Profile (at part side surface)
1. Preheating	150 to 180 °C 60 to 120 s
2. Temperature up (down)	+4 °C/s or less (- 6 °C/s or less)
3. Reflow temperature	Over 230 °C 10 to 30 s Max. 5 °C/s
4. Peak temperature	Max. 240 ± 5 °C



(2) Reflow conditions

- (a) Make sure the temperature of the upper surface of the seal glass resin adhesive portion of the package does not exceed 245 °C.
- (b) Perform the reflow soldering only one time.
- (c) Finish reflow soldering within 72 h after unsealing the degassed packing.

 Store the products under the condition of temperature of 30 °C or less and humidity of 70 % RH or less after unsealing the package.
- (d) Perform re-baking only one time under the condition at 125 °C for 24 h.

(3) Others

- (a) Carry out evaluation for the solder joint reliability in your company.
- (b) After the reflow, the paste residue of protective tape may remain around the seal glass. (The paste residue of protective tape should be ignored except remarkable one.)
- (c) Note that X-ray inspection may damage characteristics of the sensor.

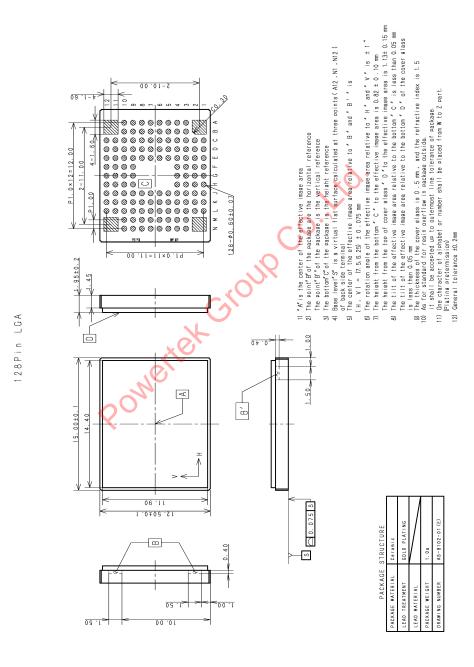
5. Others

- (1) Do not expose to strong light (sun rays) for long periods, as the color filters of color devices will be discolored.
- (2) Exposure to high temperature or humidity will affect the characteristics. Accordingly avoid storage or use in such conditions.
- (3) This product is precision optical parts, so care should be taken not to apply excessive mechanical shocks or force.
- (4) Note that imaging characteristics of the sensor may be affected when approaching strong electromagnetic wave or magnetic field during operation.
- (5) Note that image may be affected by the light leaked to optical black when using an infrared cut filter that has transparency in near infrared ray area during shooting subjects with high luminance.

Material_No.14-0.0.6

Package Outline

(Unit: mm)



List of Trademark Logos and Definition Statements

Powertek Group Co. Itd.